



US008378938B2

(12) **United States Patent**
Nathan et al.

(10) **Patent No.:** **US 8,378,938 B2**
(45) **Date of Patent:** **Feb. 19, 2013**

(54) **METHOD AND SYSTEM FOR
PROGRAMMING AND DRIVING ACTIVE
MATRIX LIGHT EMITTING DEVICE PIXEL
HAVING A CONTROLLABLE SUPPLY
VOLTAGE**

(75) Inventors: **Arokia Nathan**, Cambridge (GB);
Gholamreza Chaji, Waterloo (CA);
Peyman Servati, Vancouver (CA)

(73) Assignee: **Ignis Innovation Inc.**, Waterloo (CA)

(*) Notice: Subject to any disclaimer, the term of this
patent is extended or adjusted under 35
U.S.C. 154(b) by 0 days.

(21) Appl. No.: **13/243,065**

(22) Filed: **Sep. 23, 2011**

(65) **Prior Publication Data**

US 2012/0007842 A1 Jan. 12, 2012

Related U.S. Application Data

(63) Continuation of application No. 12/851,652, filed on
Aug. 6, 2010, which is a continuation of application
No. 11/298,240, filed on Dec. 7, 2005, now Pat. No.
7,800,565.

(30) **Foreign Application Priority Data**

Dec. 7, 2004 (CA) 2490858

(51) **Int. Cl.**
G09G 3/30 (2006.01)

(52) **U.S. Cl.** 345/78; 345/82

(58) **Field of Classification Search** 345/76-78,
345/82-83; 315/169.3

See application file for complete search history.

(56) **References Cited**

U.S. PATENT DOCUMENTS

4,996,523 A	2/1991	Bell et al.
5,266,515 A	11/1993	Robb et al.
5,498,880 A	3/1996	Lee et al.
5,619,033 A	4/1997	Weisfield
5,648,276 A	7/1997	Hara et al.
5,714,968 A	2/1998	Ikeda
5,748,160 A	5/1998	Shieh et al.
5,874,803 A	2/1999	Garbuzov et al.
5,880,582 A	3/1999	Sawada
5,903,248 A	5/1999	Irwin
5,917,280 A	6/1999	Burrows et al.

(Continued)

FOREIGN PATENT DOCUMENTS

CA	2249592	7/1998
CA	2368386	9/1999

(Continued)

OTHER PUBLICATIONS

Chaiji et al.: "Dynamic-effect compensating technique for stable
a-Si:H AMOLED displays"; dated Aug. 2005 (4 pages).

(Continued)

Primary Examiner — Chanh Nguyen

Assistant Examiner — Long D Pham

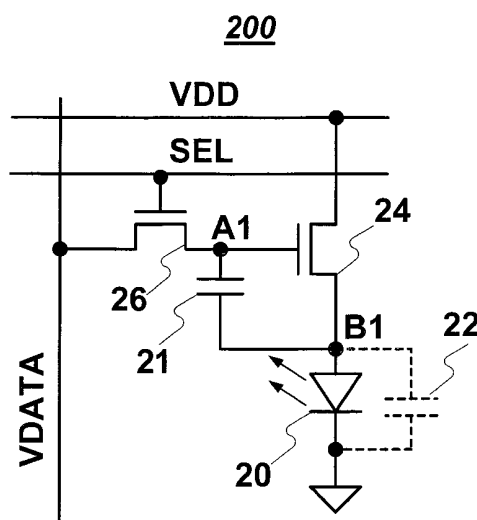
(74) *Attorney, Agent, or Firm* — Nixon Peabody LLP

(57)

ABSTRACT

Method and system for programming and driving active
matrix light emitting device pixel is provided. The pixel is a
voltage programmed pixel circuit, and has a light emitting
device, a driving transistor and a storage capacitor. The pixel
has a programming cycle having a plurality of operating
cycles, and a driving cycle. During the programming cycle,
the voltage of the connection between the OLED and the
driving transistor is controlled so that the desired gate-source
voltage of a driving transistor is stored in a storage capacitor.

18 Claims, 22 Drawing Sheets



U.S. PATENT DOCUMENTS

5,952,789	A	9/1999	Stewart et al.
5,990,629	A	11/1999	Yamada et al.
6,023,259	A	2/2000	Howard et al.
6,069,365	A	5/2000	Chow et al.
6,091,203	A	7/2000	Kawashima et al.
6,097,360	A	8/2000	Holloman
6,144,222	A	11/2000	Ho
6,229,508	B1	5/2001	Kane
6,246,180	B1	6/2001	Nishigaki
6,252,248	B1	6/2001	Sano et al.
6,288,696	B1	9/2001	Holloman
6,307,322	B1	10/2001	Dawson et al.
6,323,631	B1	11/2001	Juang
6,392,617	B1	5/2002	Gleason
6,433,488	B1	8/2002	Bu
6,501,466	B1	12/2002	Yamagashi et al.
6,580,408	B1	6/2003	Bae et al.
6,693,610	B2	2/2004	Shannon et al.
6,697,057	B2	2/2004	Koyama et al.
6,734,636	B2	5/2004	Sanford et al.
6,859,193	B1	2/2005	Yumoto
6,919,871	B2	7/2005	Kwon
6,940,214	B1	9/2005	Komiya et al.
7,129,914	B2	10/2006	Knapp et al.
7,248,236	B2	7/2007	Nathan et al.
7,310,092	B2	12/2007	Forrest et al.
2001/0002703	A1	6/2001	Koyama
2001/0026257	A1	10/2001	Kimura
2001/0030323	A1	10/2001	Ikeda
2001/0043173	A1	11/2001	Troutman
2001/0045929	A1	11/2001	Prache
2002/0000576	A1	1/2002	Inukai
2002/0011796	A1	1/2002	Koyama
2002/0011799	A1	1/2002	Kimura
2002/0195968	A1	12/2002	Sanford et al.
2003/0062524	A1	4/2003	Kimura
2003/0090481	A1	5/2003	Kimura
2003/0095087	A1	5/2003	Libsch
2003/0107560	A1	6/2003	Yumoto et al.
2003/0111966	A1	6/2003	Mikami et al.
2003/0197663	A1	10/2003	Lee et al.
2003/0230980	A1	12/2003	Forrest et al.
2004/0070557	A1	4/2004	Asano et al.
2004/0145547	A1	7/2004	Oh
2004/0150595	A1	8/2004	Kasai
2004/0155841	A1	8/2004	Kasai
2004/0174349	A1	9/2004	Libsch
2004/0196275	A1	10/2004	Hattori
2004/0252089	A1	12/2004	Ono et al.
2005/0007357	A1	1/2005	Yamashita et al.
2005/0067971	A1	3/2005	Kane
2005/0206590	A1	9/2005	Sasaki et al.
2005/0285825	A1	12/2005	Eom et al.
2006/0261841	A1	11/2006	Fish

FOREIGN PATENT DOCUMENTS

CA	2242720	1/2000
CA	2354018	6/2000
CA	2436451	8/2002
CA	2463653	1/2004
CA	2438363	2/2005
CA	2526782	C 8/2007
EP	1 028 471	A 8/2000
EP	1 130 565	A1 9/2001
EP	1 429 312	A 6/2004
EP	1 439 520	A2 7/2004
EP	1 465 143	A 10/2004
EP	1 517 290	A2 3/2005
JP	09 090405	4/1997
JP	11 231805	8/1999
JP	2003-271095	9/2003
WO	02/067327	A 8/2002
WO	2006/053424	5/2006

OTHER PUBLICATIONS

Chaji et al.: "Electrical Compensation of OLED Luminance Degradation"; dated Dec. 2007 (3 pages).

Chaji et al.: "eUTDSP: a design study of a new VLIW-based DSP architecture"; dated May 2003 (4 pages).

Chaji et al.: "Fast and Offset-Leakage Insensitive Current-Mode Line Driver for Active Matrix Displays and Sensors"; dated Feb. 2009 (8 pages).

Chaji et al.: "High Speed Low Power Adder Design With a New Logic Style: Pseudo Dynamic Logic (SDL)"; dated Oct. 2001 (4 pages).

Chaji et al.: "High-Precision, fast current source for large-area current-programmed a-Si flat panels"; dated Sep. 2006 (4 pages).

Chaji et al.: "Low-Cost AMOLED Television with IGNIS Compensating Technology"; dated May 2008 (4 pages).

Chaji et al.: "Low-Cost Stable a-Si:H AMOLED Display for Portable Applications"; dated Jun. 2006 (4 pages).

Chaji et al.: "Low-Power Low-Cost Voltage-Programmed a-Si:H AMOLED Display"; dated Jun. 2008 (5 pages).

Chaji et al.: "Merged phototransistor pixel with enhanced near infrared response and flicker noise reduction for biomolecular imaging"; dated Nov. 2008 (3 pages).

Chaji et al.: "Parallel Addressing Scheme for Voltage-Programmed Active-Matrix OLED Displays"; dated May 2007 (6 pages).

Chaji et al.: "Pseudo dynamic logic (SDL): a high-speed and low-power dynamic logic family"; dated 2002 (4 pages).

Chaji et al.: "Stable a-Si:H circuits based on short-term stress stability of amorphous silicon thin film transistors"; dated May 2006 (4 pages).

Chaji et al.: "Stable Pixel Circuit for Small-Area High-Resolution a-Si:H AMOLED Displays"; dated Oct. 2008 (6 pages).

Chaji et al.: "Stable RGBW AMOLED display with OLED degradation compensation using electrical feedback"; dated Feb. 2010 (2 pages).

Chaji et al.: "Thin-Film Transistor Integration for Biomedical Imaging and AMOLED Displays"; dated 2008 (177 pages).

European Search Report for European Application No. EP 05 82 1114 dated Mar. 27, 2009 (2 pages).

International Search Report for International Application No. PCT/CA2005/001844 dated Mar. 28, 2006 (2 pages).

Jafarabadiashtiani et al.: "A New Driving Method for a-Si AMOLED Displays Based on Voltage Feedback"; dated 2005 (4 pages).

Lee et al.: "Ambipolar Thin-Film Transistors Fabricated by PECVD Nanocrystalline Silicon"; dated 2006 (6 pages).

Ma e y et al.: "Organic Light-Emitting Diode/Thin Film Transistor Integration for foldable Displays" Conference record of the 1997 International display research conference and international workshops on LCD technology and emissive technology. Toronto, Sep. 15-19, 1997 (6 pages).

Matsueda y et al.: "35.1: 2.5-in. AMOLED with Integrated 6-bit Gamma Compensated Digital Data Driver"; dated May 2004 (4 pages).

Nathan et al.: "Backplane Requirements for Active Matrix Organic Light Emitting Diode Displays"; dated 2006 (16 pages).

Nathan et al.: "Call for papers second international workshop on compact thin-film transistor (TFT) modeling for circuit simulation"; dated Sep. 2009 (1 page).

Nathan et al.: "Driving schemes for a-Si and LTPS AMOLED displays"; dated Dec. 2005 (11 pages).

Nathan et al.: "Invited Paper: a -Si for AMOLED—Meeting the Performance and Cost Demands of Display Applications (Cell Phone to HDTV)"; dated 2006 (4 pages).

Nathan et al.: "Thin film imaging technology on glass and plastic"; dated Oct. 31-Nov. 2, 2000 (4 pages).

Philipp: "Charge transfer sensing" Sensor Review, vol. 19, No. 2, Dec. 31, 1999, 10 pages.

Rafati et al.: "Comparison of a 17 b multiplier in Dual-rail domino and in Dual-rail D L (D L) logic styles"; dated 2002 (4 pages).

Safavian et al.: "Three-TFT image sensor for real-time digital X-ray imaging"; dated Feb. 2, 2006 (2 pages).

Safavian et al.: "3-TFT active pixel sensor with correlated double sampling readout circuit for real-time medical x-ray imaging"; dated Jun. 2006 (4 pages).

Safavian et al.: "A novel current scaling active pixel sensor with correlated double sampling readout circuit for real time medical x-ray imaging"; dated May 2007 (7 pages).

- Safavian et al.: "A novel hybrid active-passive pixel with correlated double sampling CMOS readout circuit for medical x-ray imaging"; dated May 2008 (4 pages).
- Safavian et al.: "Self-compensated a-Si:H detector with current-mode readout circuit for digital X-ray fluoroscopy"; dated Aug. 2005 (4 pages).
- Safavian et al.: "TFT active image sensor with current-mode readout circuit for digital x-ray fluoroscopy [5969D-82]"; dated Sep. 2005 (9 pages).
- Stewart M. et al., "Polysilicon TFT technology for active matrix OLED displays" IEEE transactions on electron devices, vol. 48, No. 5 (7 pages).
- Vygranenko et al.: "Stability of indium-oxide thin-film transistors by reactive ion beam assisted deposition"; dated 2009.
- Wang et al.: "Indium oxides by reactive ion beam assisted evaporation: From material study to device application"; dated Mar. 2009 (6 pages).
- Extended European Search Report mailed Nov. 8, 2011 issued in corresponding European Patent Application No. 11175223.4 (8 pages).
- Ahnood et al.: "Effect of threshold voltage instability on field effect mobility in thin film transistors deduced from constant current measurements"; dated Aug. 2009.
- Alexander et al.: "Pixel circuits and drive schemes for glass and elastic AMOLED displays"; dated Jul. 2005 (9 pages).
- Alexander et al.: "Unique Electrical Measurement Technology for Compensation, Inspection, and Process Diagnostics of AMOLED HDTV"; dated May 2010 (4 pages).
- Ashtiani et al.: "AMOLED Pixel Circuit With Electronic Compensation of Luminance Degradation"; dated Mar. 2007 (4 pages).
- Chaji et al.: "A Current-Mode Comparator for Digital Calibration of Amorphous Silicon AMOLED Displays"; dated Jul. 2008 (5 pages).
- Chaji et al.: "A fast settling current driver based on the CCH for AMOLED displays"; dated Dec. 2009 (6 pages).
- Chaji et al.: "A Low-Cost Stable Amorphous Silicon AMOLED Display with Full V~T- and V~O~L~E~D Shift Compensation"; dated May 2007 (4 pages).
- Chaji et al.: "A low-power driving scheme for a-Si:H active-matrix organic light-emitting diode displays"; dated Jun. 2005 (4 pages).
- Chaji et al.: "A low-power high-performance digital circuit for deep submicron technologies"; dated Jun. 2005 (4 pages).
- Chaji et al.: "A novel a-Si:H AMOLED pixel circuit based on short-term stress stability of a-Si:H TFTs"; dated Oct. 2005 (3 pages).
- Chaji et al.: "A Novel Driving Scheme and Pixel Circuit for AMOLED Displays"; dated Jun. 2006 (4 pages).
- Chaji et al.: "A novel driving scheme for high-resolution large-area a-Si:H AMOLED displays"; dated Aug. 2005 (4 pages).
- Chaji et al.: "A Stable Voltage-Programmed Pixel Circuit for a-Si:H AMOLED Displays"; dated Dec. 2006 (12 pages).
- Chaji et al.: "A Sub- μ A fast-settling current-programmed pixel circuit for AMOLED displays"; dated Sep. 2007.
- Chaji et al.: "An Enhanced and Simplified Optical Feedback Pixel Circuit for AMOLED Displays"; dated Oct. 2006.
- Chaji et al.: "Compensation technique for DC and transient instability of thin film transistor circuits for large-area devices"; dated Aug. 2008.
- Chaji et al.: "Driving scheme for stable operation of 2-TFT a-Si AMOLED pixel"; dated Apr. 2005 (2 pages).

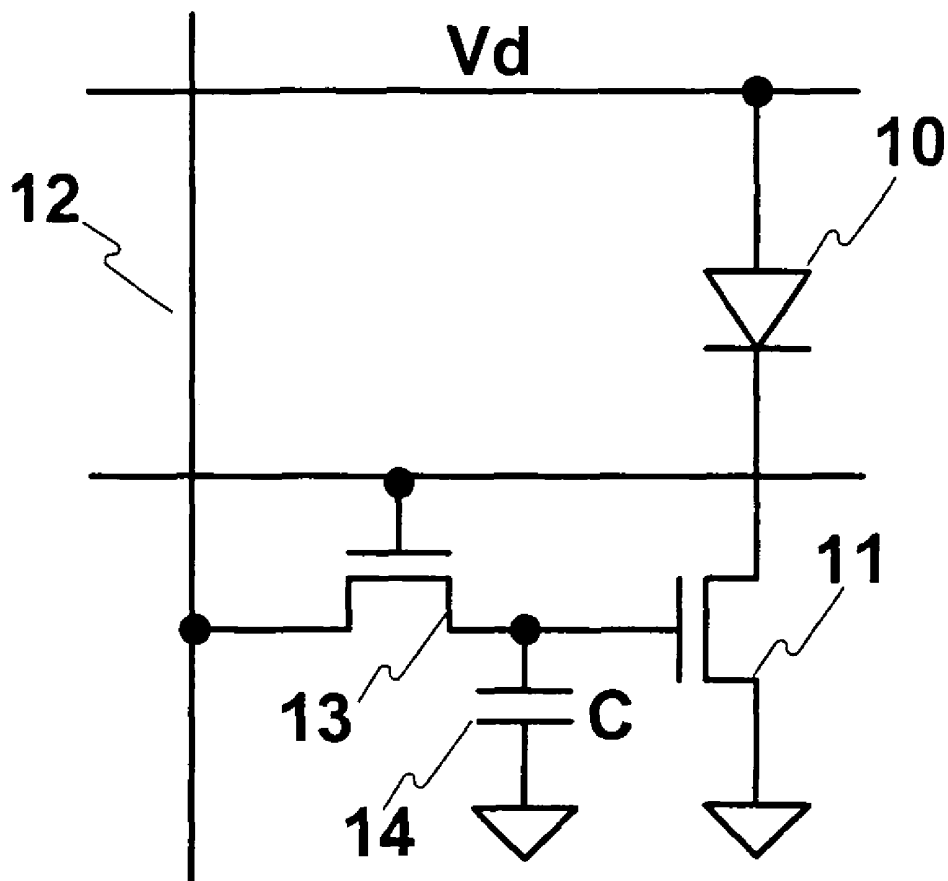


Figure 1
Prior Art

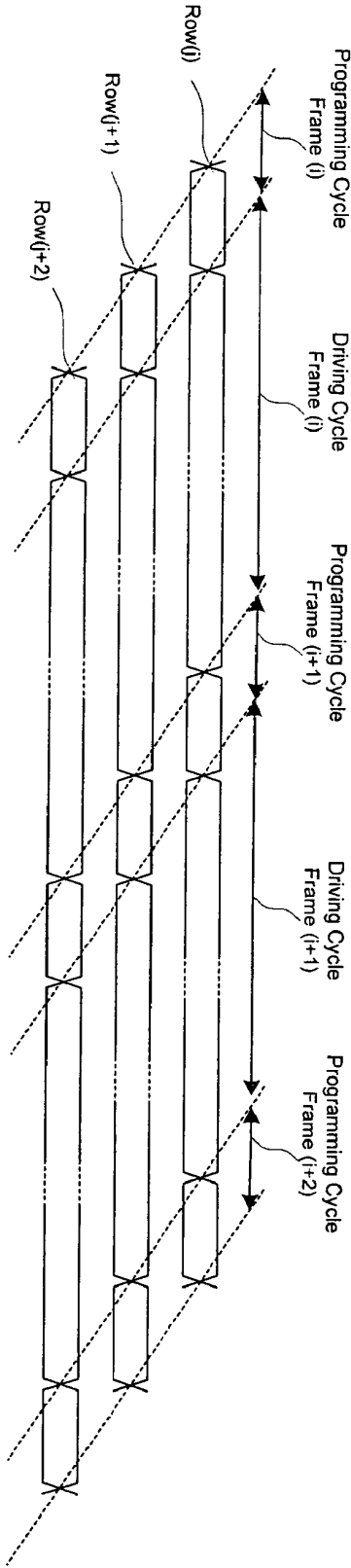


Figure 2

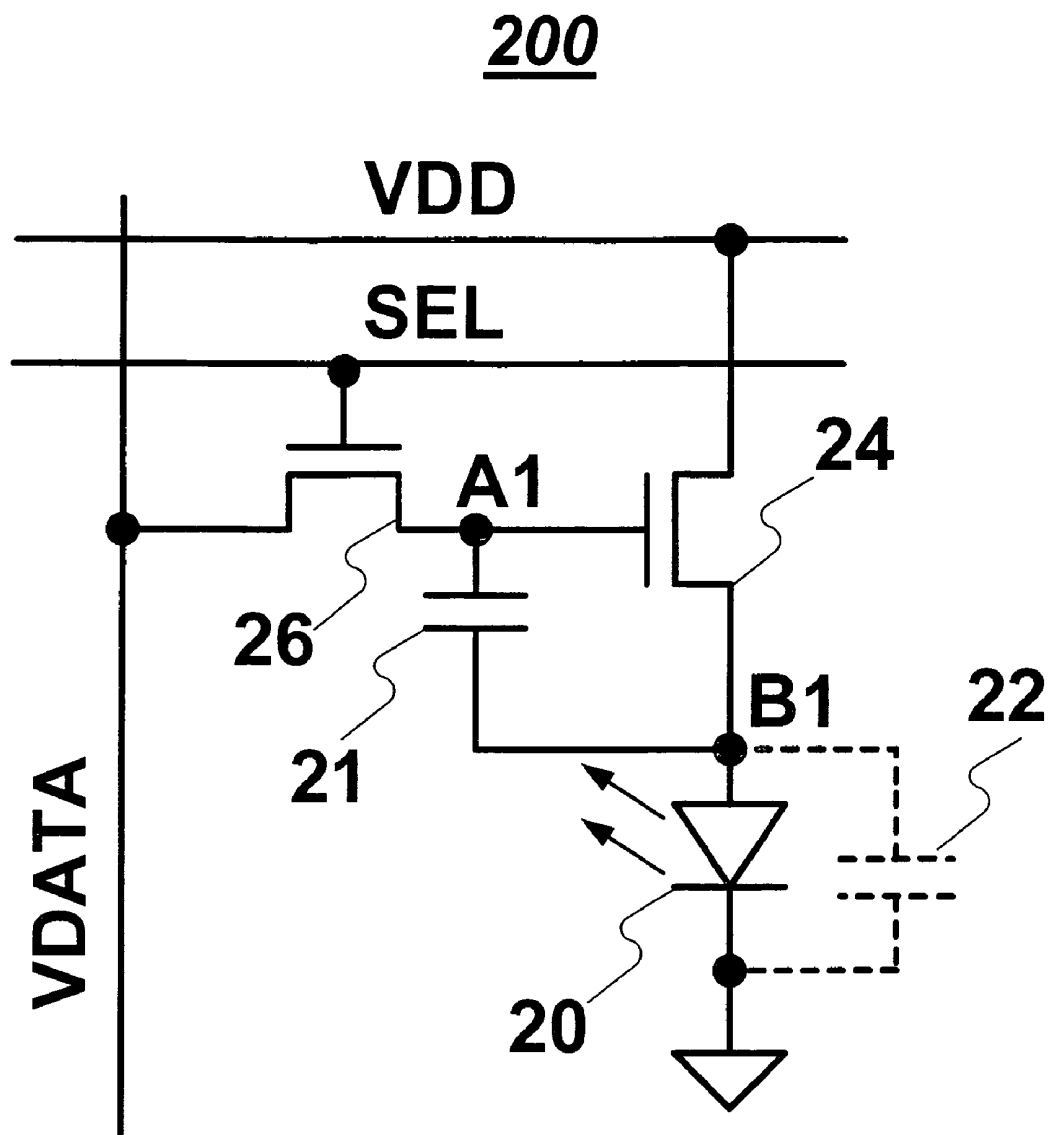
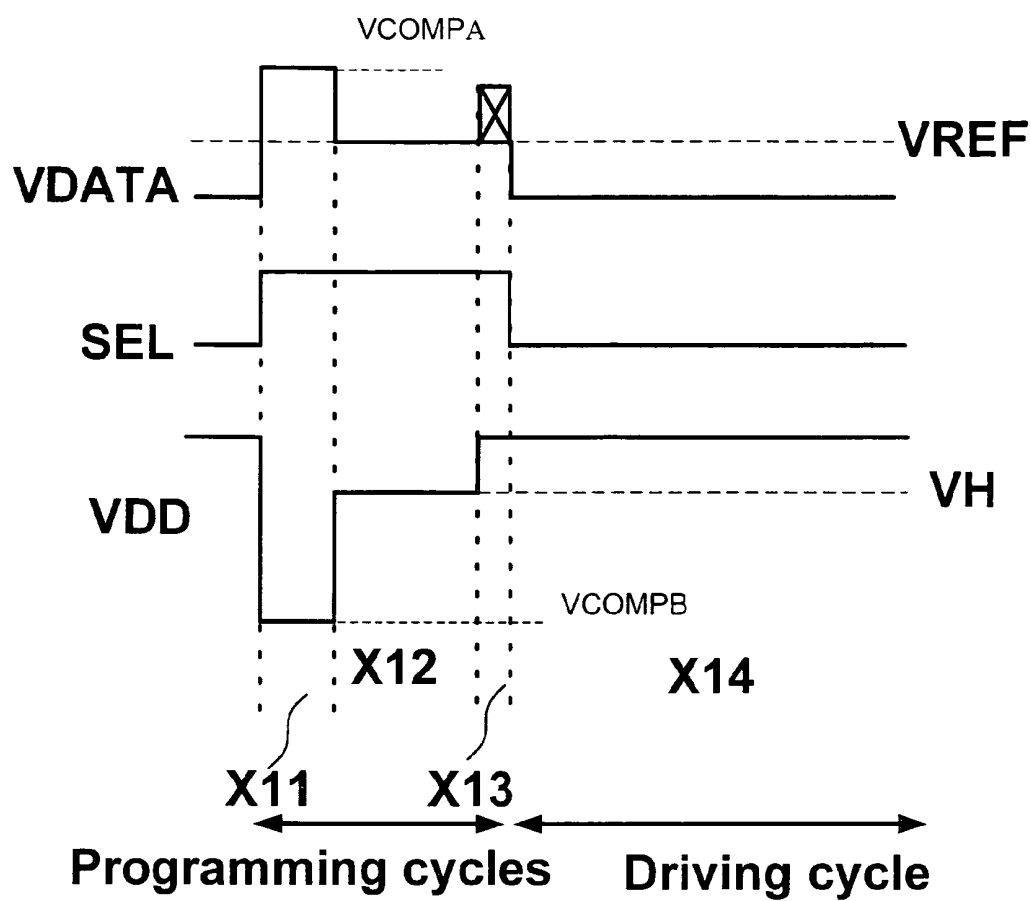
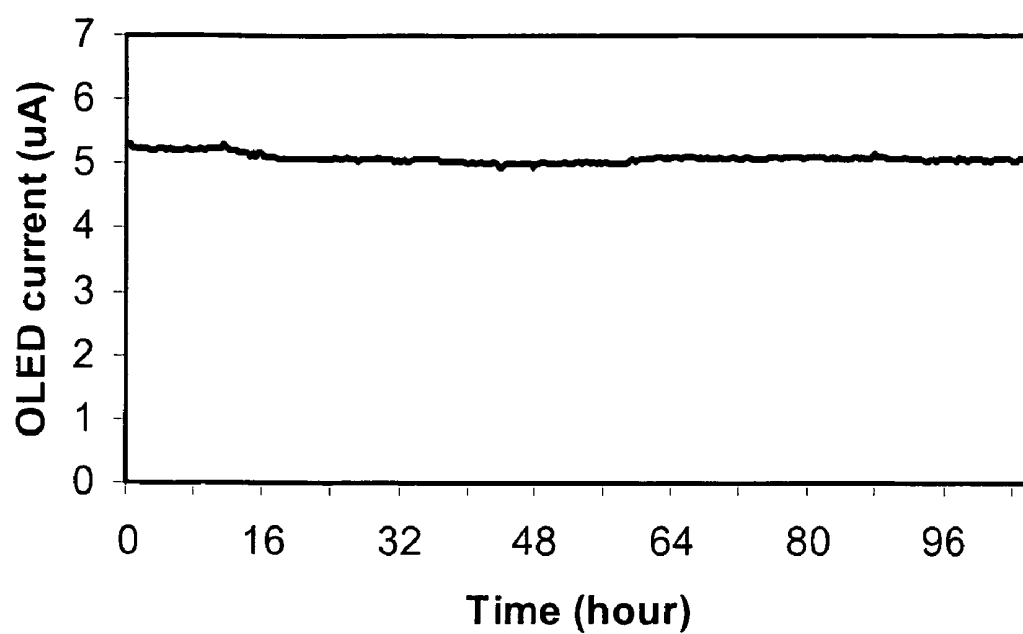
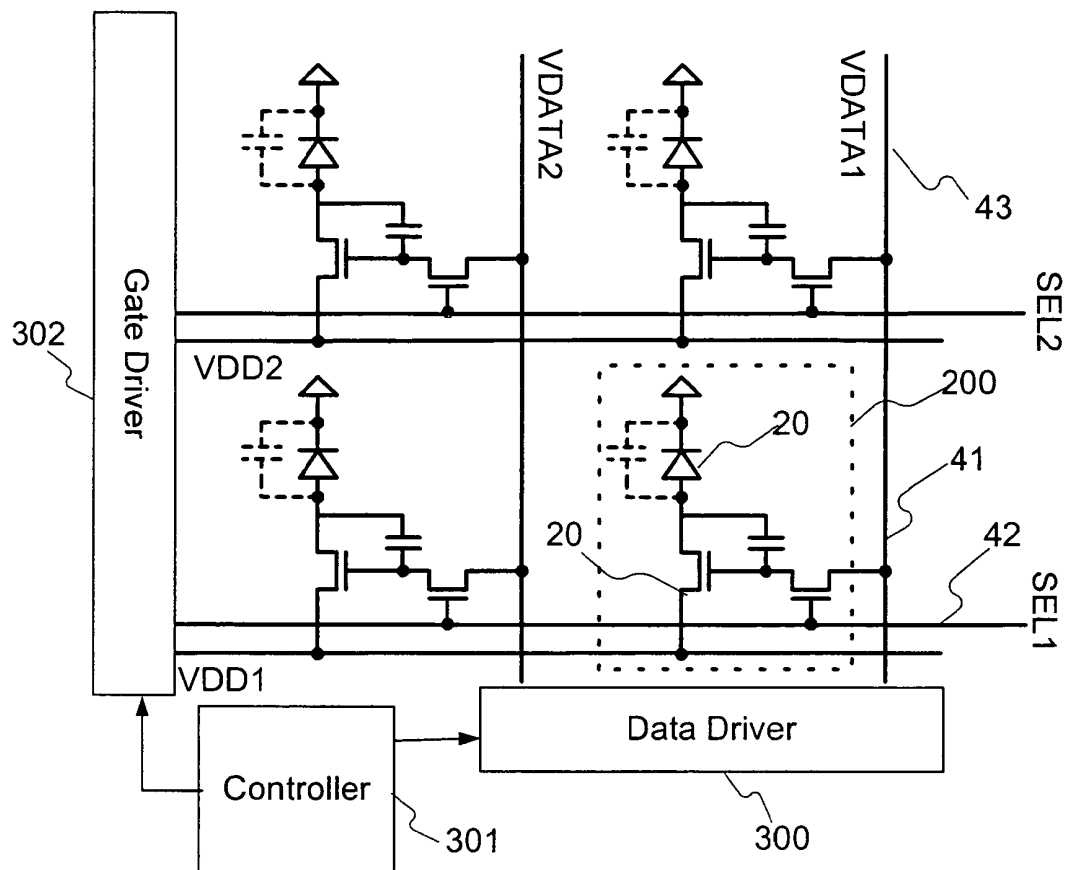
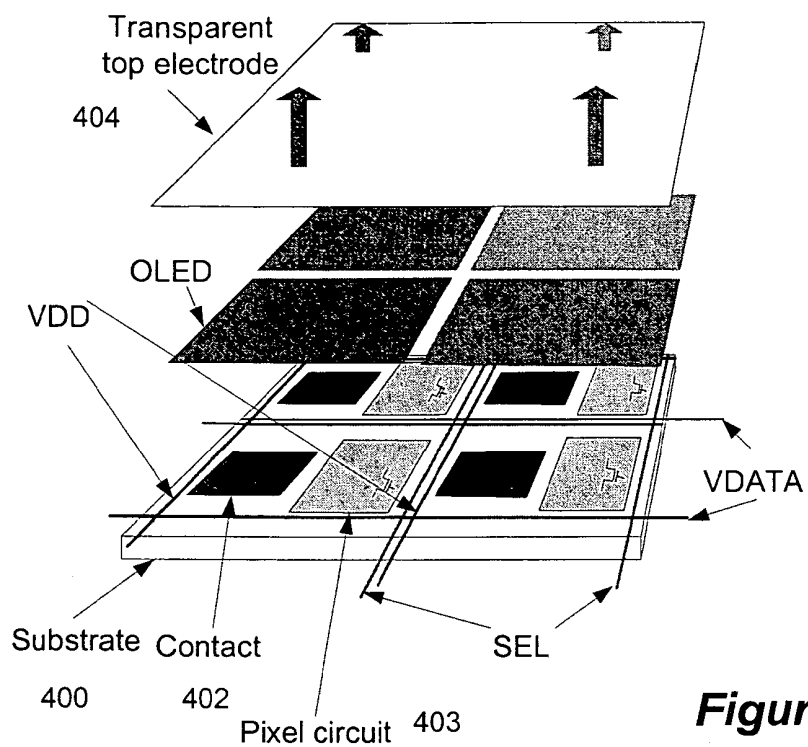
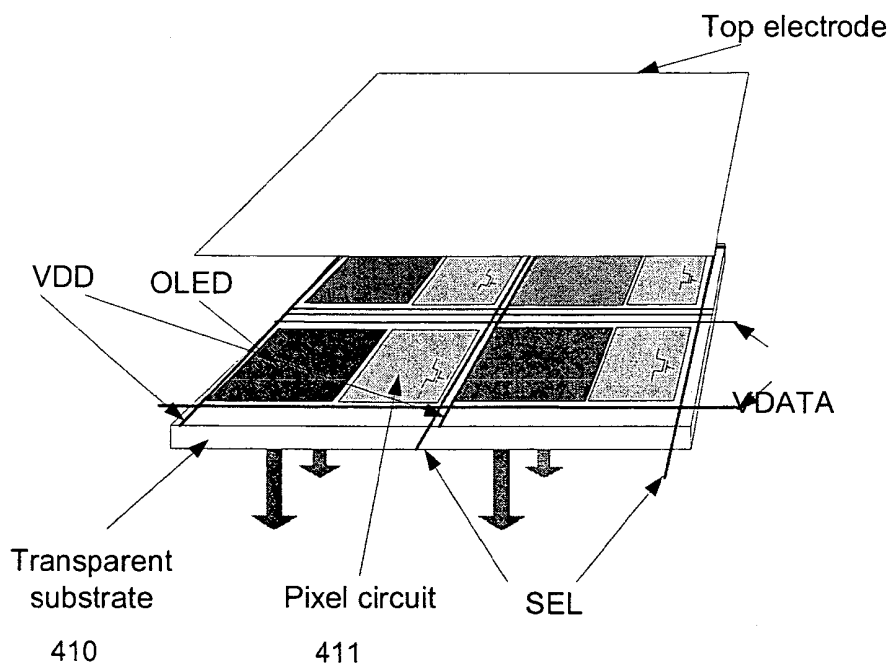


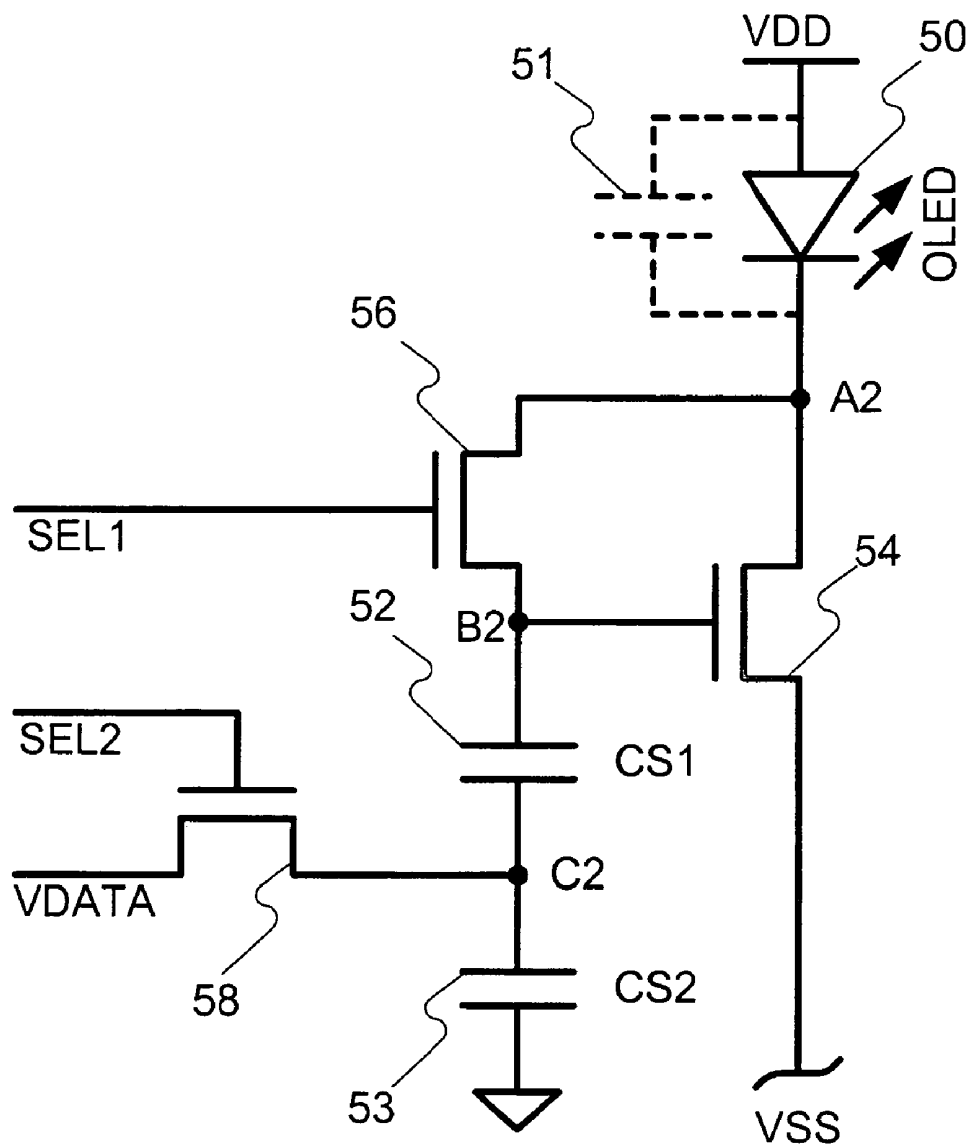
Figure 3

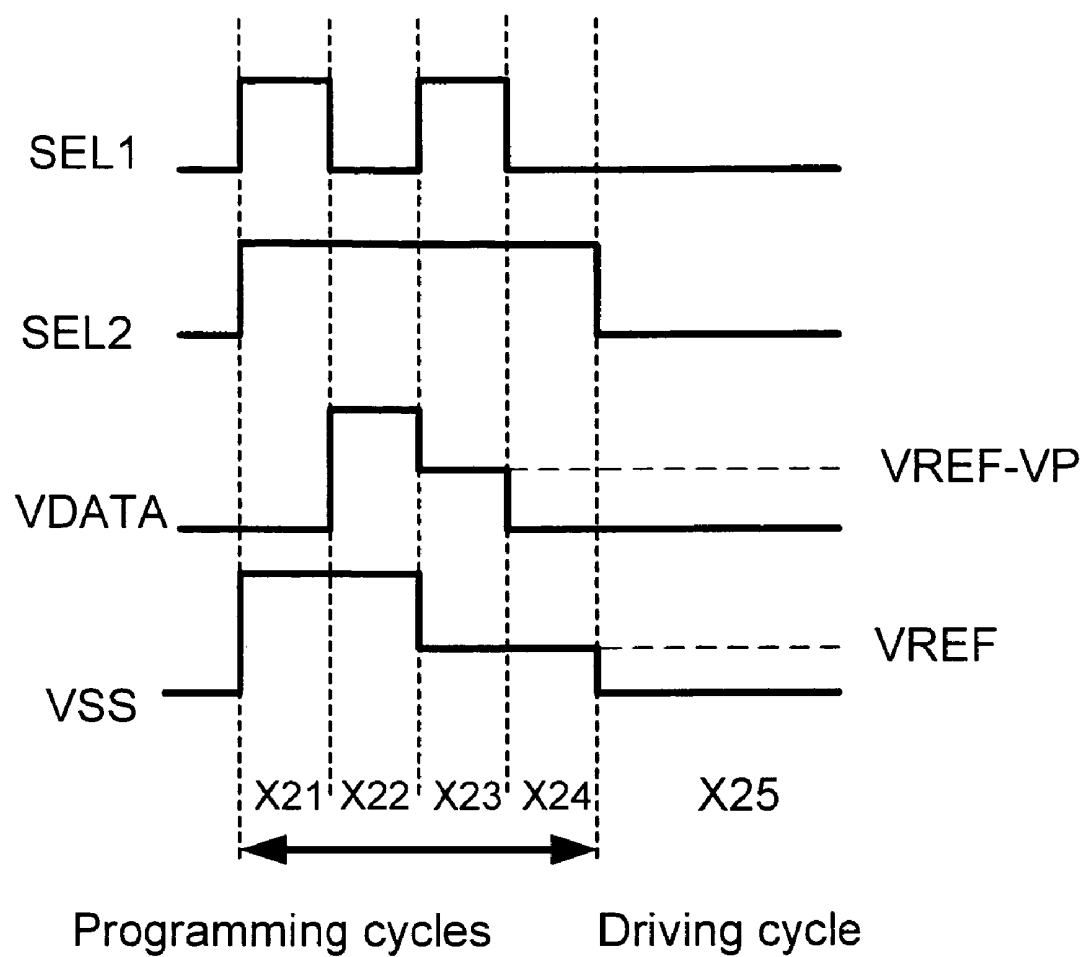
**Figure 4**

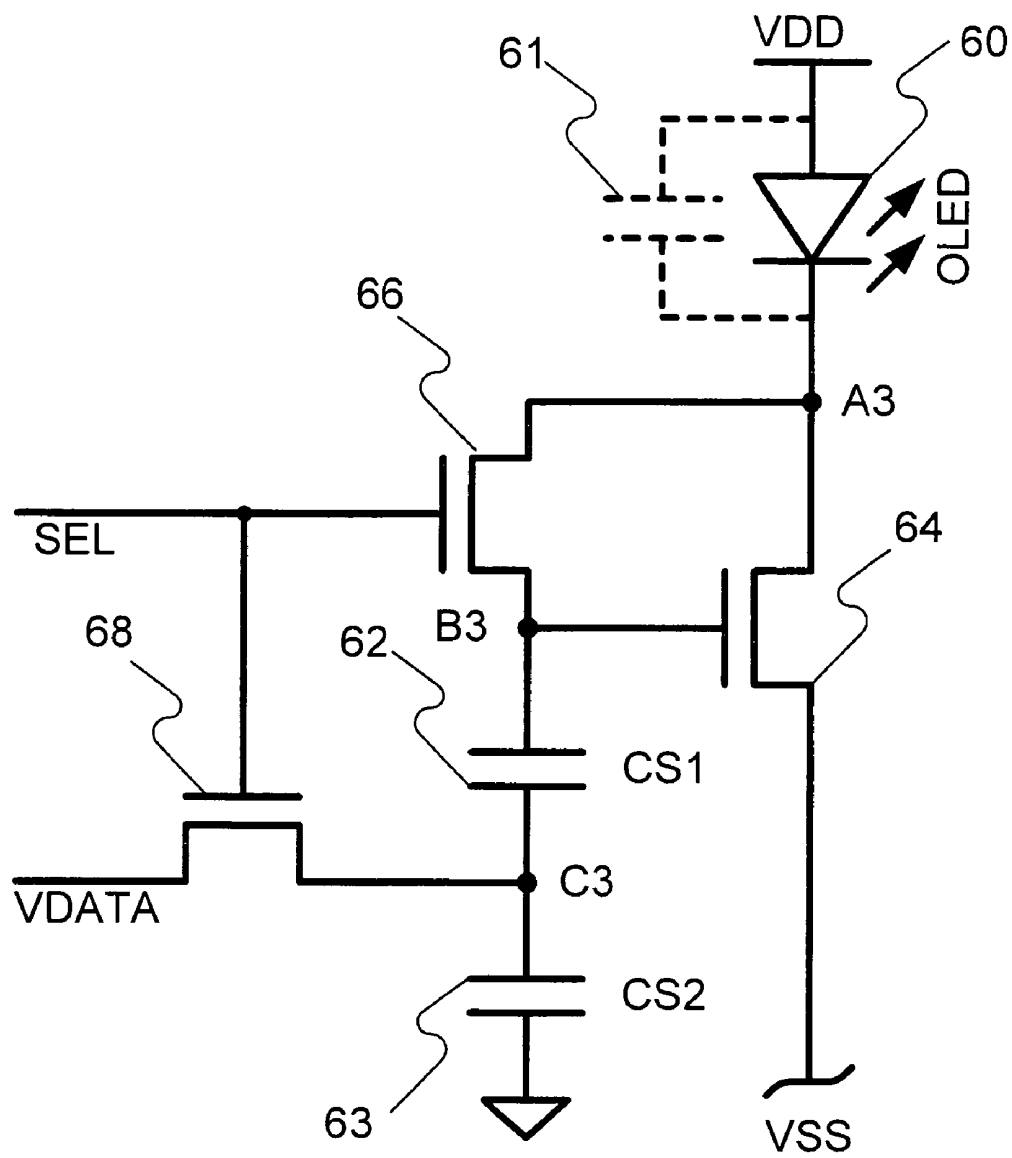
**Figure 5**

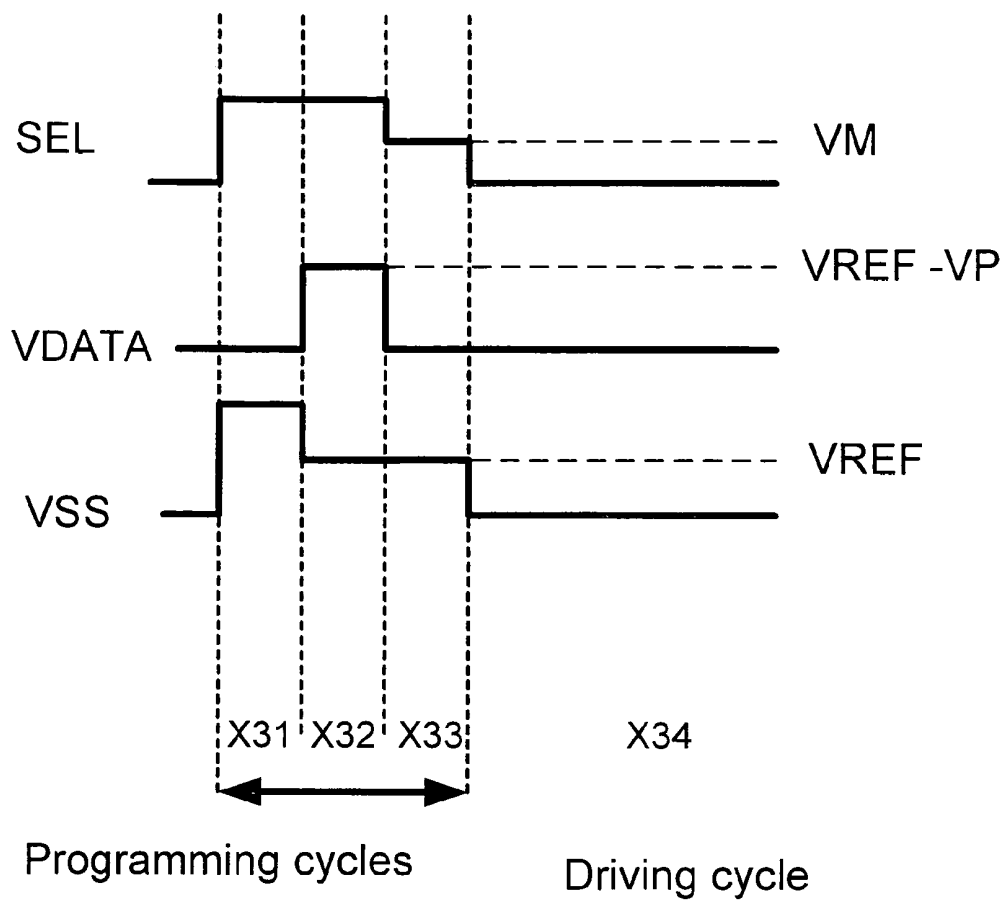
**Figure 6**

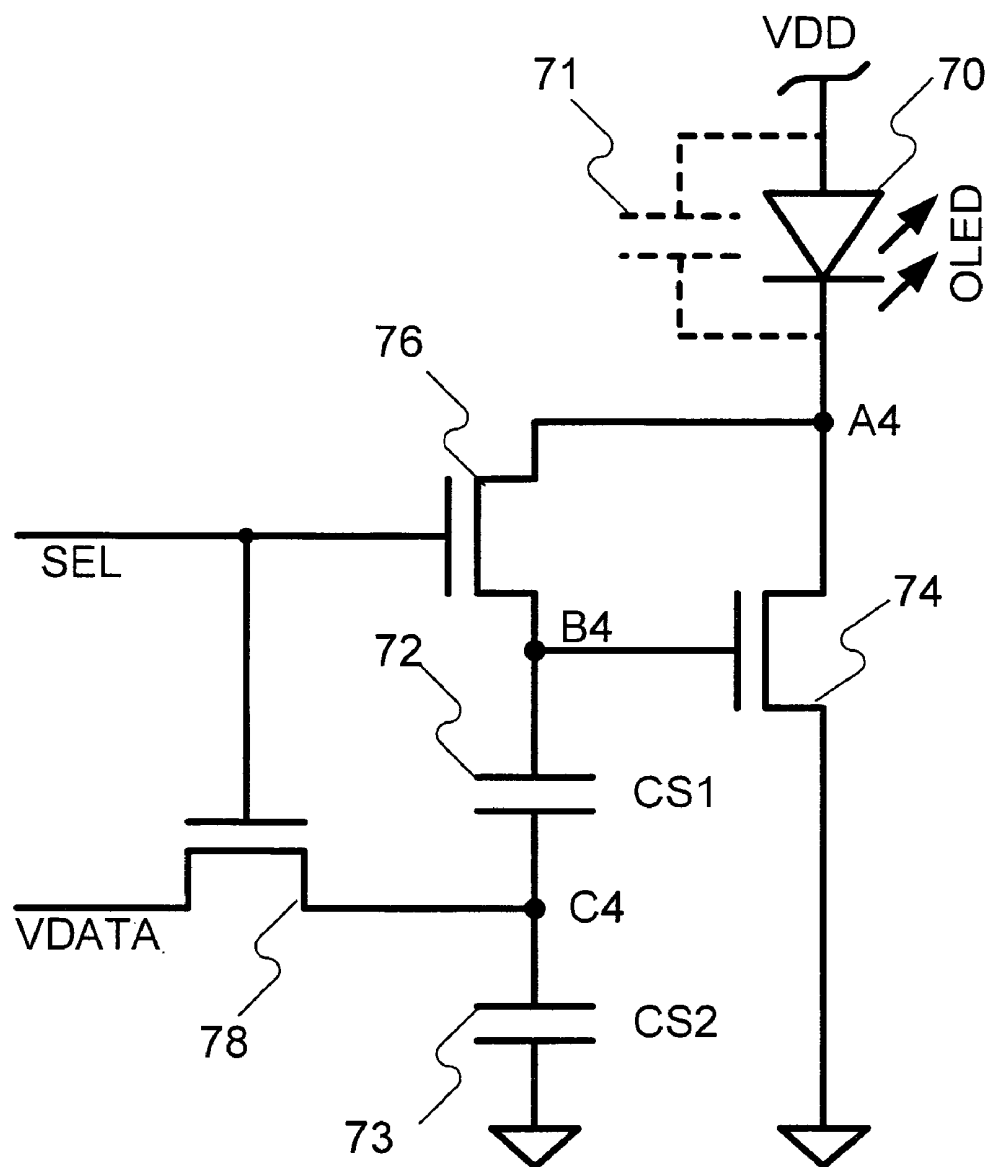
**Figure 7(a)****Top emission pixels****Bottom emission pixels****Figure 7(b)**

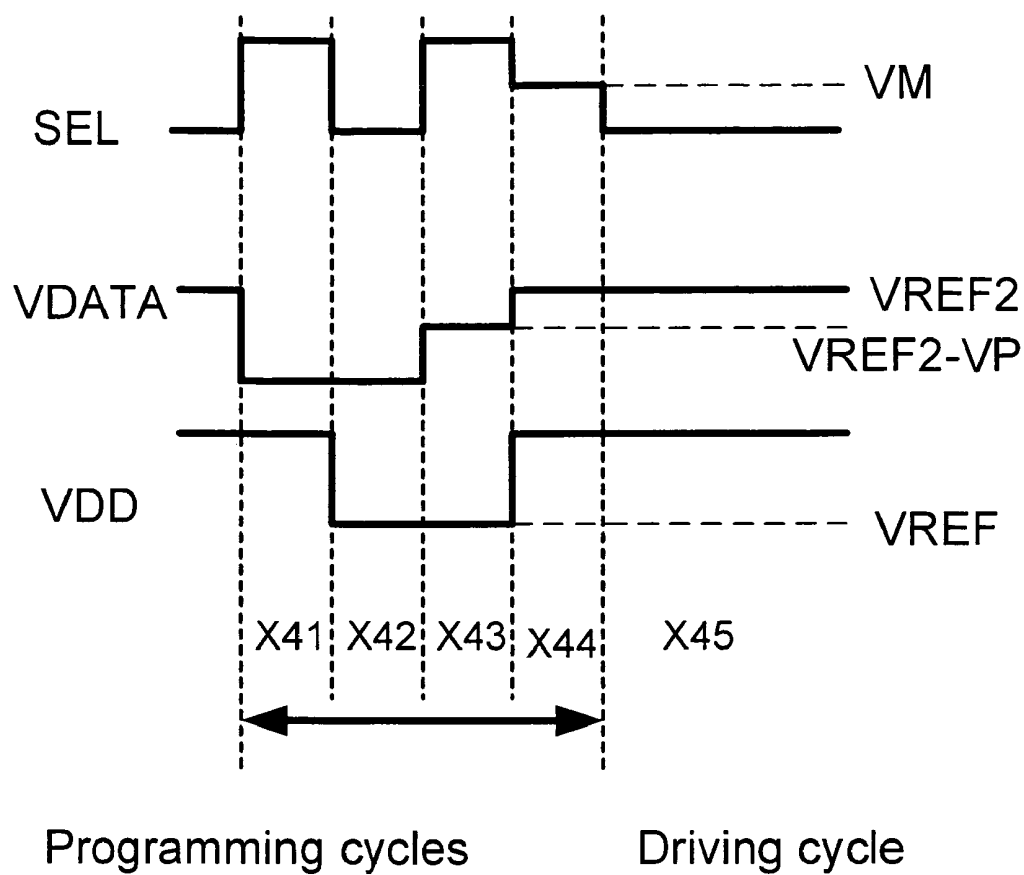
202**Figure 8**

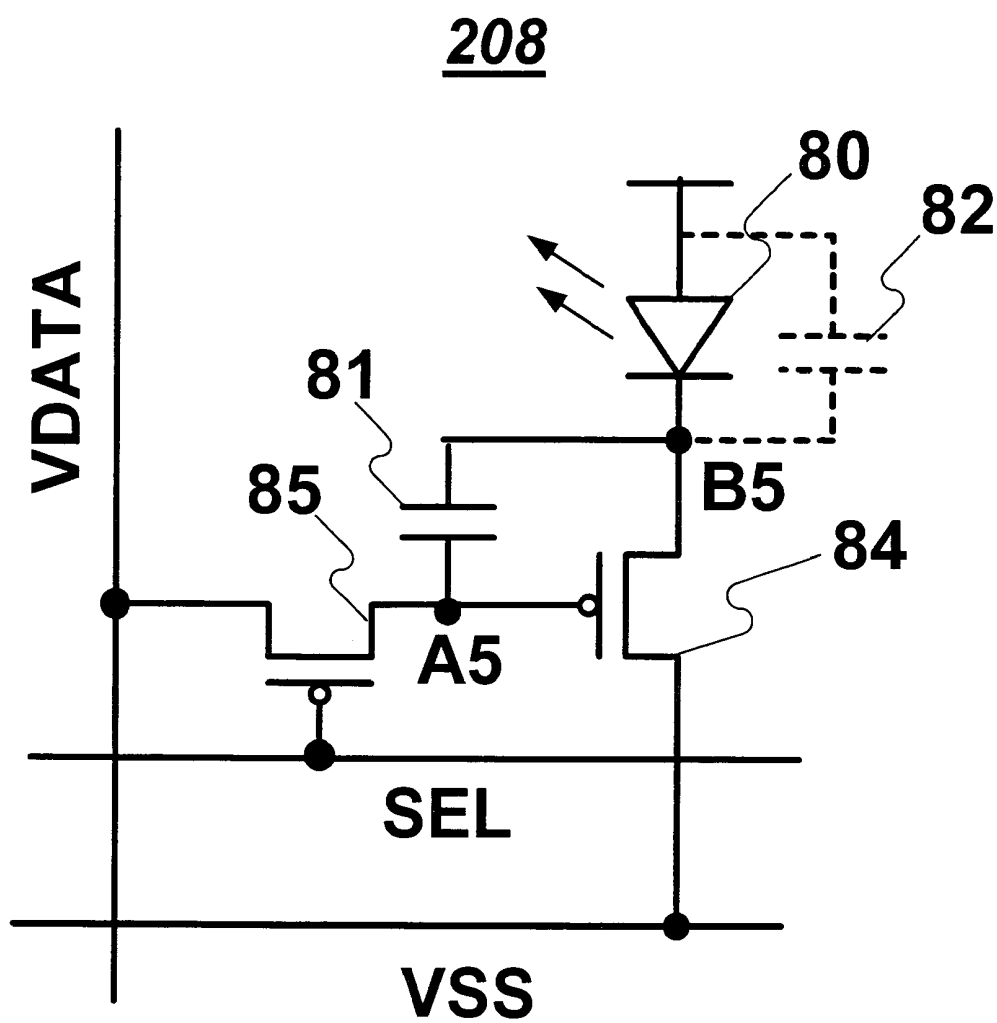
**Figure 9**

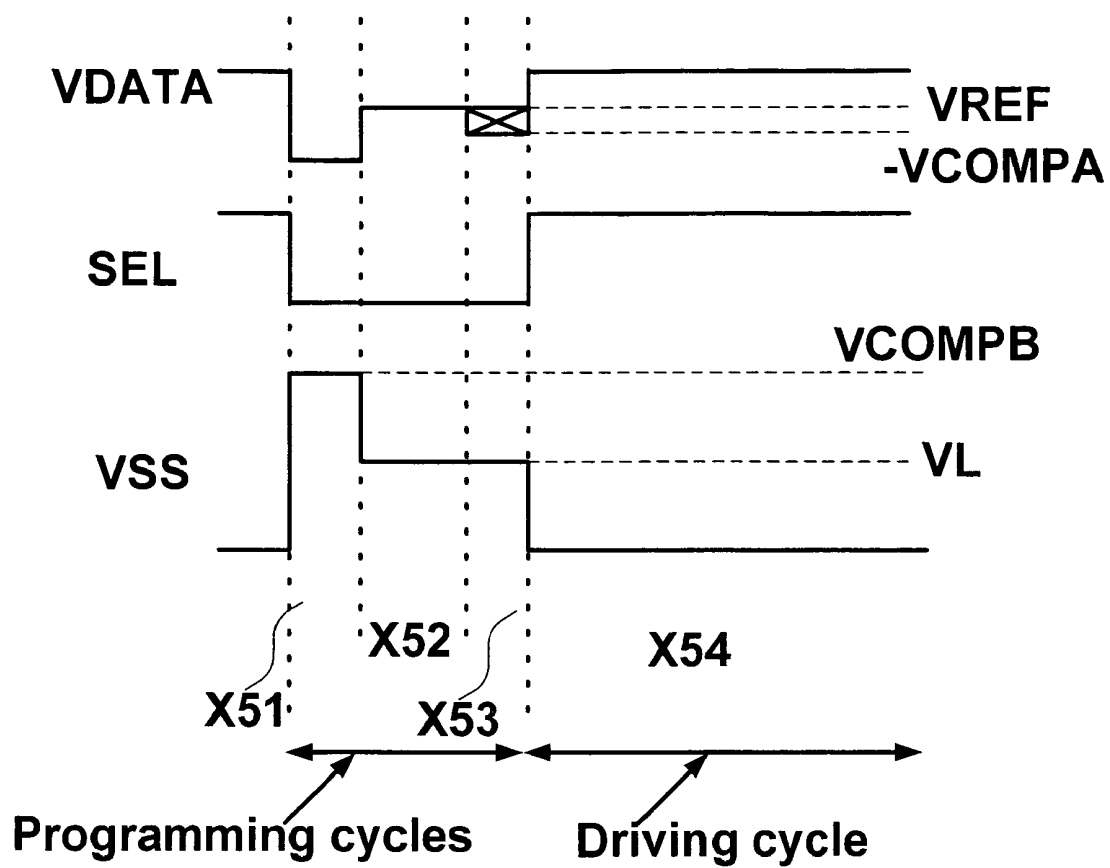
204**Figure 10**

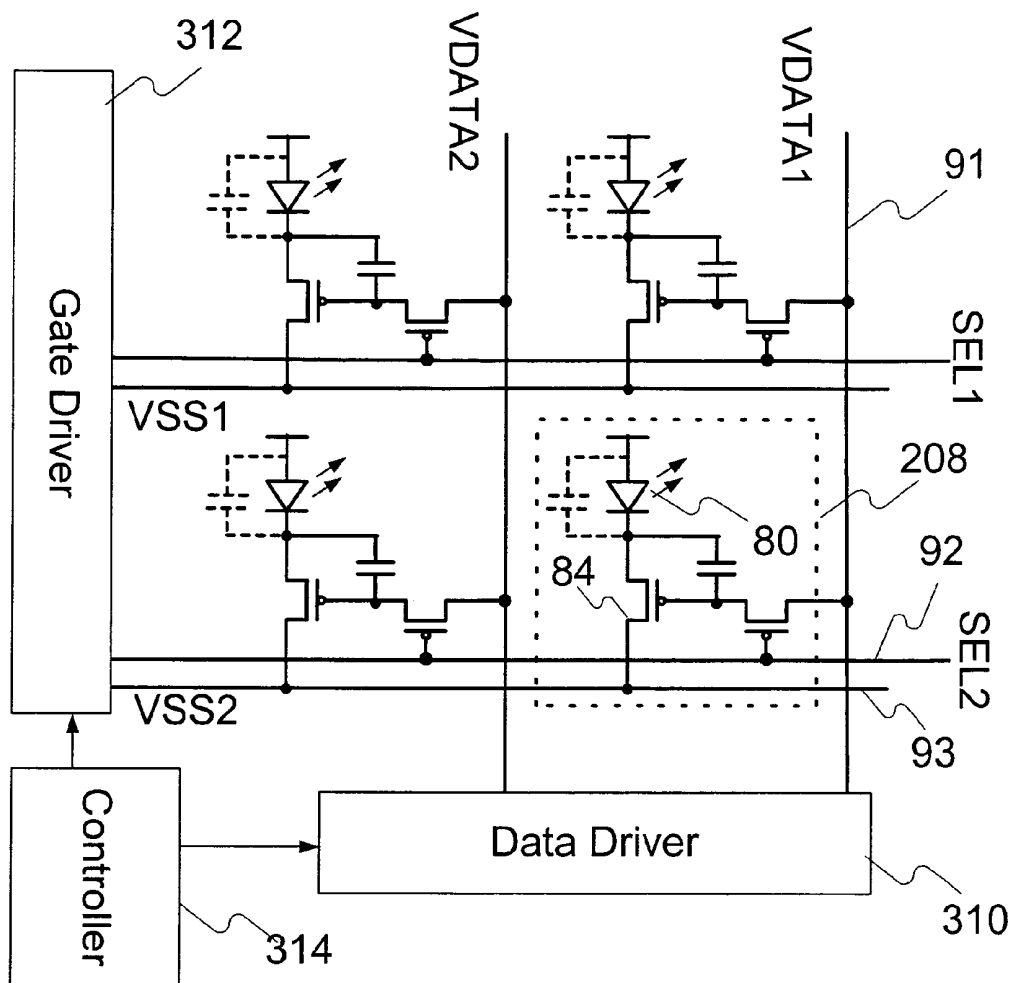
**Figure 11**

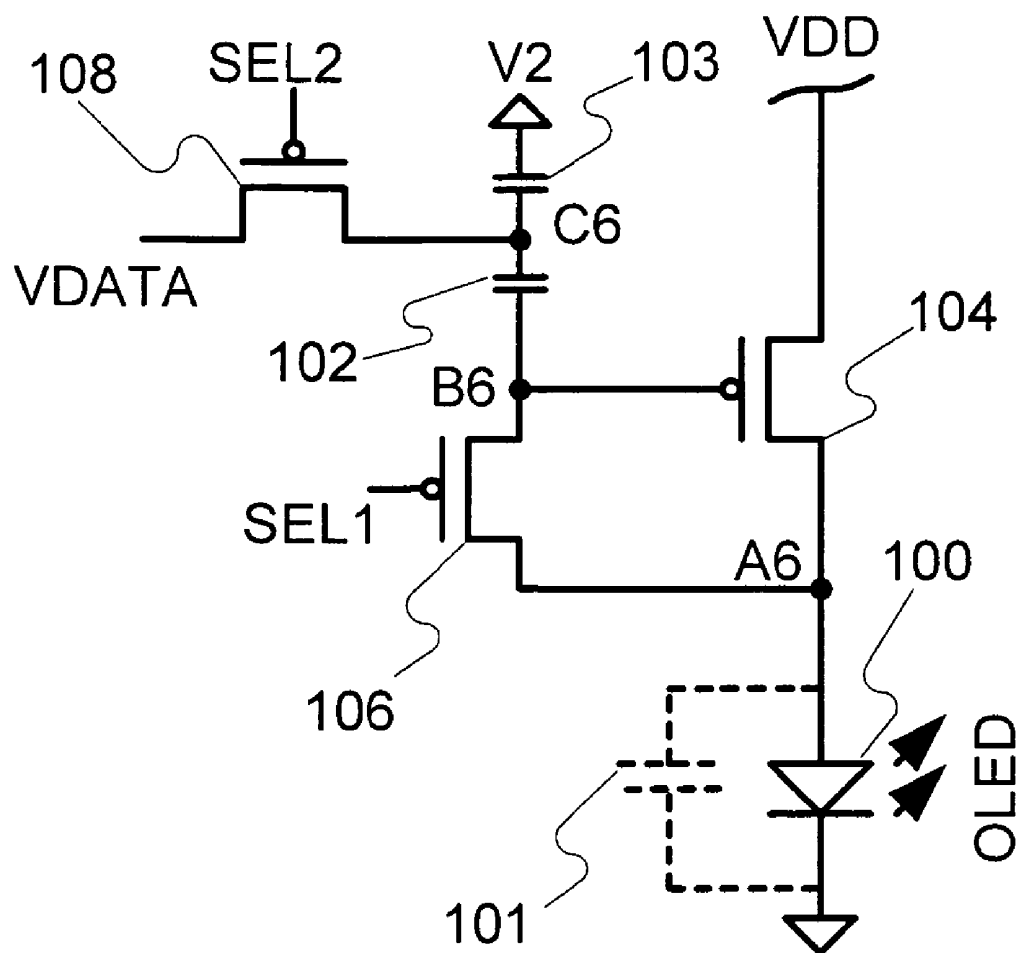
206**Figure 12**

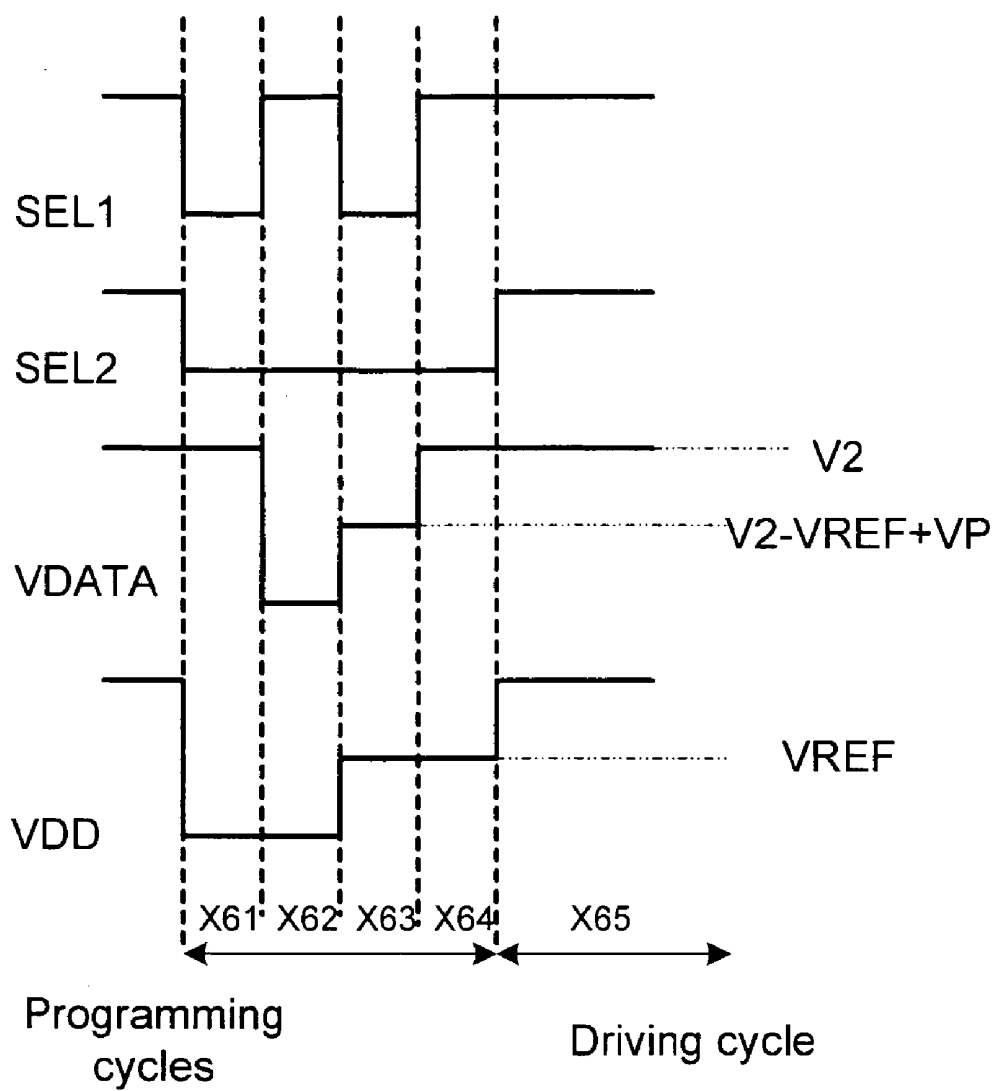
**Figure 13**

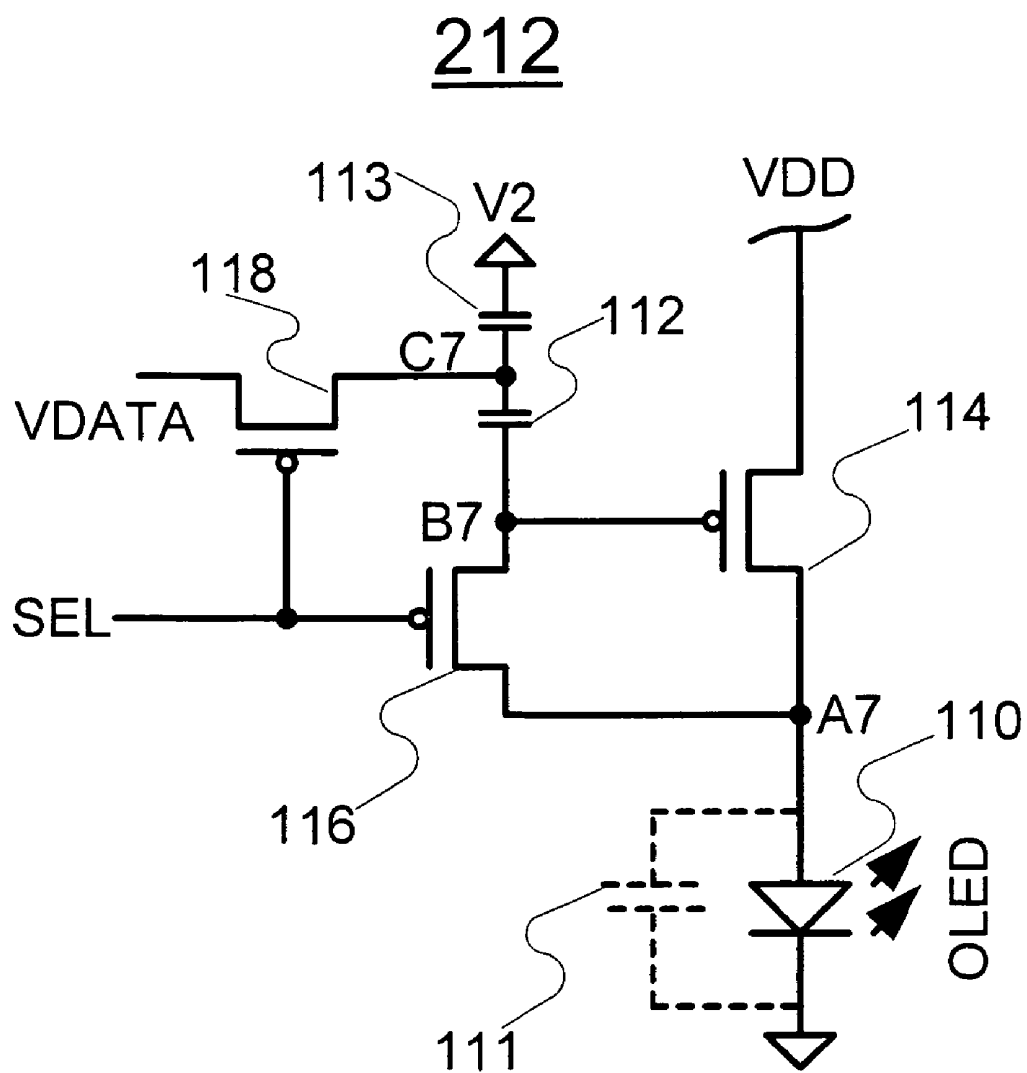
*Figure 14*

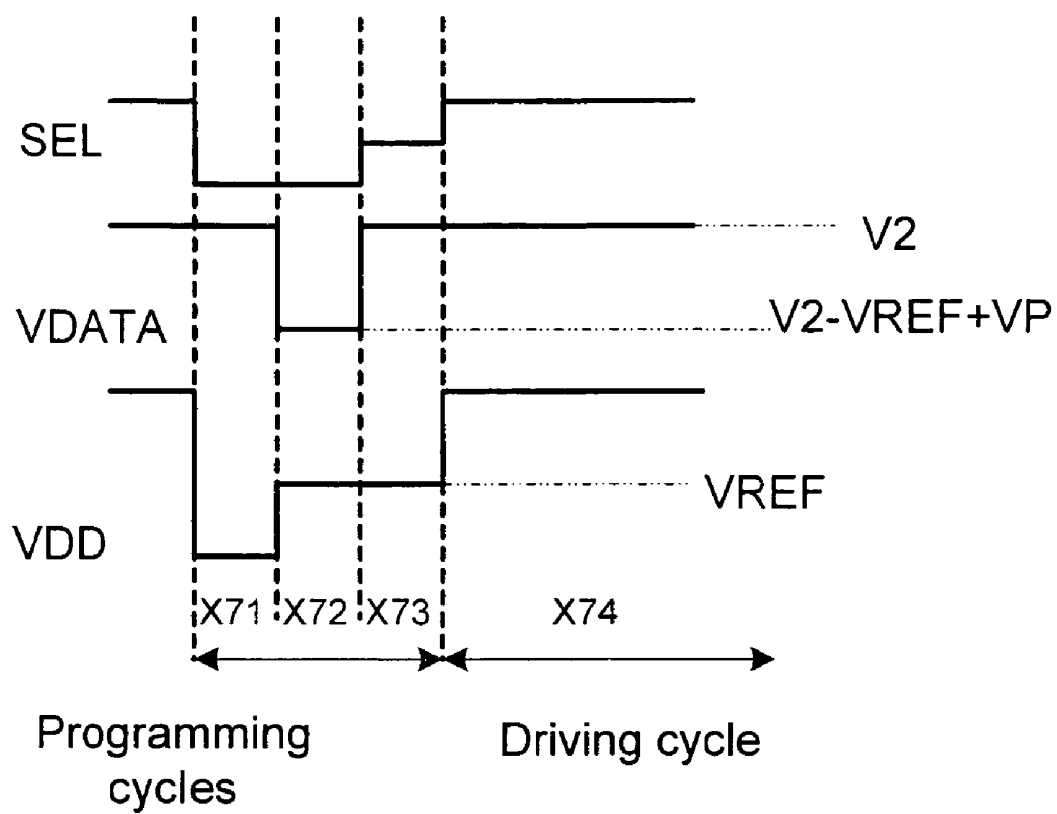
*Figure 15*

**Figure 16**

210**Figure 17**

**Figure 18**

**Figure 19**

**Figure 20**

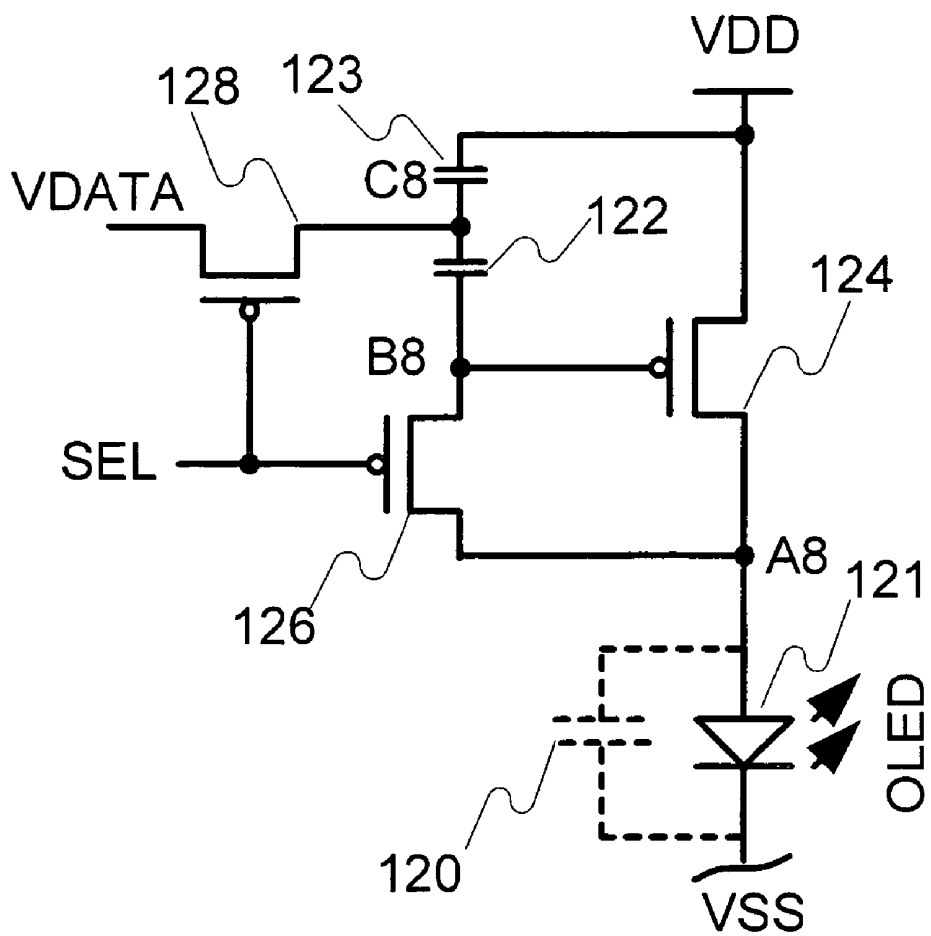
214**Figure 21**

Figure 22

1

METHOD AND SYSTEM FOR PROGRAMMING AND DRIVING ACTIVE MATRIX LIGHT EMITTING DEVICE PIXEL HAVING A CONTROLLABLE SUPPLY VOLTAGE

CROSS REFERENCE TO RELATED APPLICATIONS

This application is a continuation of U.S. patent application Ser. No. 12/851,652, filed Aug. 6, 2010; which is a continuation of U.S. patent application Ser. No. 11/298,240, filed Dec. 7, 2005, now issued as U.S. Pat. No. 7,800,565, which claims priority to Canadian Patent No. 2,490,858, filed Dec. 7, 2004, each of which is incorporated herein by reference in its entirety.

FIELD OF INVENTION

The present invention relates to a light emitting device displays, and more specifically to a driving technique for the light emitting device displays.

BACKGROUND OF THE INVENTION

Recently active-matrix organic light-emitting diode (AMOLED) displays with amorphous silicon (a-Si), polysilicon, organic, or other driving backplane have become more attractive due to advantages over active matrix liquid crystal displays. An AMOLED display using a-Si backplanes, for example, has the advantages which include low temperature fabrication that broadens the use of different substrates and makes flexible displays feasible, and its low cost fabrication that yields high resolution displays with a wide viewing angle.

The AMOLED display includes an array of rows and columns of pixels, each having an organic light-emitting diode (OLED) and backplane electronics arranged in the array of rows and columns. Since the OLED is a current driven device, the pixel circuit of the AMOLED should be capable of providing an accurate and constant drive current.

FIG. 1 shows a pixel circuit as disclosed in U.S. Pat. No. 5,748,160. The pixel circuit of FIG. 1 includes an OLED 10, a driving thin film transistor (TFT) 11, a switch TFT 13, and a storage capacitor 14. The drain terminal of the driving TFT 11 is connected to the OLED 10. The gate terminal of the driving TFT 11 is connected to a column line 12 through the switch TFT 13. The storage capacitor 14, which is connected between the gate terminal of the driving TFT 11 and the ground, is used to maintain the voltage at the gate terminal of the driving TFT 11 when the pixel circuit is disconnected from the column line 12. The current through the OLED 10 strongly depends on the characteristic parameters of the driving TFT 11. Since the characteristic parameters of the driving TFT 11, in particular the threshold voltage under bias stress, vary by time, and such changes may differ from pixel to pixel, the induced image distortion may be unacceptably high.

U.S. Pat. No. 6,229,508 discloses a voltage-programmed pixel circuit which provides, to an OLED, a current independent of the threshold voltage of a driving TFT. In this pixel, the gate-source voltage of the driving TFT is composed of a programming voltage and the threshold voltage of the driving TFT. A drawback of U.S. Pat. No. 6,229,508 is that the pixel circuit requires extra transistors, and is complex, which results in a reduced yield, reduced pixel aperture, and reduced lifetime for the display.

2

Another method to make a pixel circuit less sensitive to a shift in the threshold voltage of the driving transistor is to use current programmed pixel circuits, such as pixel circuits disclosed in U.S. Pat. No. 6,734,636. In the conventional current programmed pixel circuits, the gate-source voltage of the driving TFT is self-adjusted based on the current that flows through it in the next frame, so that the OLED current is less dependent on the current-voltage characteristics of the driving TFT. A drawback of the current-programmed pixel circuit is that an overhead associated with low programming current levels arises from the column line charging time due to the large line capacitance.

SUMMARY OF THE INVENTION

It is an object of the invention to provide a method and system that obviates or mitigates at least one of the disadvantages of existing systems.

In accordance with an aspect to the present invention there is provided a method of programming and driving a display system, the display system includes: a display array having a plurality of pixel circuits arranged in row and column, each pixel circuit having: a light emitting device having a first terminal and a second terminal, the first terminal of the lighting device being connected to a voltage supply electrode; a capacitor having a first terminal and a second terminal; a switch transistor having a gate terminal, a first terminal and a second terminal, the gate terminal of the switch transistor being connected to a select line, the first terminal of the switch transistor being connected to a signal line for transferring voltage data, the second terminal of the switch transistor being connected to the first terminal of the capacitor; and a driving transistor having a gate terminal, a first terminal and a second terminal, the gate terminal of the driving transistor being connected to the second terminal of the switch transistor and the first terminal of the capacitor at a first node (A), the first terminal of the driving transistor being connected to the second terminal of the light emitting device and the second terminal of the capacitor at a second node (B), the second terminal of the driving transistor being connected to a controllable voltage supply line; a driver for driving the select line, the controllable voltage supply line and the signal line to operate the display array; the method including the steps of: at a programming cycle, at a first operating cycle, charging the second node at a first voltage defined by $(V_{REF}-V_T)$ or $(-V_{REF}+V_T)$, where V_{REF} represents a reference voltage and V_T represents a threshold voltage of the driving transistor; at a second operating cycle, charging the first node at a second voltage defined by $(V_{REF}+V_P)$ or $(-V_{REF}+V_P)$ so that the difference between the first and second node voltages is stored in the storage capacitor, where V_P represents a programming voltage; at a driving cycle, applying the voltage stored in the storage capacitor to the gate terminal of the driving transistor.

In accordance with a further aspect to the present invention there is provided a method of programming and driving a display system, the display system includes: a display array having a plurality of pixel circuits arranged in row and column, each pixel circuit having: a light emitting device having a first terminal and a second terminal, the first terminal of the lighting device being connected to a voltage supply electrode; a first capacitor and a second capacitor, each having a first terminal and a second terminal; a first switch transistor having a gate terminal, a first terminal and a second terminal, the gate terminal of the first switch transistor being connected to a first select line, the first terminal of the first switch transistor being connected to the second terminal of the light emitting device,

the second terminal of the first switch being connected to the first terminal of the first capacitor; a second switch transistor having a gate terminal, a first terminal and a second terminal, the gate terminal of the second switch transistor being connected to a second select line, the first terminal of the second switch transistor being connected to a signal line for transferring voltage data; a driving transistor having a gate terminal, a first terminal and a second terminal, the first terminal of the driving transistor being connected to the second terminal of the light emitting device at a first node (A), the gate terminal of the driving transistor being connected to the second terminal of the first switch transistor and the first terminal of the first capacitor at a second node (B), the second terminal of the driving transistor being connected to a controllable voltage supply line; the second terminal of the second switch transistor being connected to the second terminal of the first capacitor and the first terminal of the second capacitor at a third node (C); a driver for driving the first and second select line, the controllable voltage supply line and the signal line to operate the display array, the method including the steps of: at a programming cycle, at a first operating cycle, controlling the voltage of each of the first node and the second node so as to store $(VT+VP)$ or $-(VT+VP)$ in the first storage capacitor, where VT represents a threshold voltage of the driving transistor, VP represents a programming voltage; at a second operating cycle, discharging the third node; at a driving cycle, applying the voltage stored in the storage capacitor to the gate terminal of the driving transistor.

In accordance with a further aspect to the present invention there is provided a display system including: a display array having a plurality of pixel circuits arranged in row and column, each pixel circuit having: a light emitting device having a first terminal and a second terminal, the first terminal of the lighting device being connected to a voltage supply electrode; a capacitor having a first terminal and a second terminal; a switch transistor having a gate terminal, a first terminal and a second terminal, the gate terminal of the switch transistor being connected to a select line, the first terminal of the switch transistor being connected to a signal line for transferring voltage data, the second terminal of the switch transistor being connected to the first terminal of the capacitor; and a driving transistor having a gate terminal, a first terminal and a second terminal, the gate terminal of the driving transistor being connected to the second terminal of the switch transistor and the first terminal of the capacitor at a first node (A), the first terminal of the driving transistor being connected to the second terminal of the light emitting device and the second terminal of the capacitor at a second node (B), the second terminal of the driving transistor being connected to a controllable voltage supply line; a driver for driving the select line, the controllable voltage supply line and the signal line to operate the display array; and a controller for implementing a programming cycle and a driving cycle on each row of the display array using the driver; wherein the programming cycle includes a first operating cycle and a second operating cycle, wherein at the first operating cycle, the second node is charged at a first voltage defined by $(VREF-VT)$ or $(-VREF+VT)$, where $VREF$ represents a reference voltage and VT represents a threshold voltage of the driving transistor, at the second operating cycle, the first node is charged at a second voltage defined by $(VREF+VP)$ or $(-VREF+VP)$ so that the difference between the first and second node voltages is stored in the storage capacitor, where VP represents a programming voltage; wherein at the driving cycle, the voltage stored in the storage capacitor is applied to the gate terminal of the driving transistor.

In accordance with a further aspect to the present invention there is provided a display system including: a display array having a plurality of pixel circuits arranged in row and column, each pixel circuit having: a light emitting device having a first terminal and a second terminal, the first terminal of the lighting device being connected to a voltage supply electrode; a first capacitor and a second capacitor, each having a first terminal and a second terminal; a first switch transistor having a gate terminal, a first terminal and a second terminal, the gate terminal of the first switch transistor being connected to a first select line, the first terminal of the first switch transistor being connected to the second terminal of the light emitting device, the second terminal of the first switch being connected to the first terminal of the first capacitor; a second switch transistor having a gate terminal, a first terminal and a second terminal, the gate terminal of the second switch transistor being connected to a second select line, the first terminal of the second switch transistor being connected to a signal line for transferring voltage data; a driving transistor having a gate terminal, a first terminal and a second terminal, the first terminal of the driving transistor being connected to the second terminal of the light emitting device at a first node (A), the gate terminal of the driving transistor being connected to the second terminal of the first switch transistor and the first terminal of the first capacitor at a second node (B), the second terminal of the driving transistor being connected to a controllable voltage supply line; the second terminal of the second switch transistor being connected to the second terminal of the first capacitor and the first terminal of the second capacitor at a third node (C); a driver for driving the first and second select line, the controllable voltage supply line and the signal line to operate the display array; and a controller for implementing a programming cycle and a driving cycle on each row of the display array using the driver; wherein the programming cycle includes a first operating cycle and a second operating cycle, wherein at the first operating cycle, the voltage of each of the first node and the second node is controlled so as to store $(VT+VP)$ or $-(VT+VP)$ in the first storage capacitor, where VT represents a threshold voltage of the driving transistor, VP represents a programming voltage, at the second operating cycle, the third node is discharged, wherein at the driving cycle, the voltage stored in the storage capacitor is applied to the gate terminal of the driving transistor.

This summary of the invention does not necessarily describe all features of the invention.

Other aspects and features of the present invention will be readily apparent to those skilled in the art from a review of the following detailed description of preferred embodiments in conjunction with the accompanying drawings.

BRIEF DESCRIPTION OF THE DRAWINGS

These and other features of the invention will become more apparent from the following description in which reference is made to the appended drawings wherein:

FIG. 1 is a diagram showing a conventional 2-TFT voltage programmed pixel circuit;

FIG. 2 is a timing diagram showing an example of programming and driving cycles in accordance with an embodiment of the present invention, which is applied to a display array;

FIG. 3 is a diagram showing a pixel circuit to which programming and driving technique in accordance with an embodiment of the present invention is applied;

FIG. 4 is a timing diagram showing an example of waveforms for programming and driving the pixel circuit of FIG. 3;

FIG. 5 is a diagram showing a lifetime test result for the pixel circuit of FIG. 3;

FIG. 6 is a diagram showing a display system having the pixel circuit of FIG. 3;

FIG. 7(a) is a diagram showing an example of the array structure having top emission pixels which are applicable to the array of FIG. 6;

FIG. 7(b) is a diagram showing an example of the array structure having bottom emission pixels which are applicable to the array of FIG. 6;

FIG. 8 is a diagram showing a pixel circuit to which programming and driving technique in accordance with a further embodiment of the present invention is applied;

FIG. 9 is a timing diagram showing an example of waveforms for programming and driving the pixel circuit of FIG. 8;

FIG. 10 is a diagram showing a pixel circuit to which programming and driving technique in accordance with a further embodiment of the present invention is applied;

FIG. 11 is a timing diagram showing an example of waveforms for programming and driving the pixel circuit of FIG. 10;

FIG. 12 is a diagram showing a pixel circuit to which programming and driving technique in accordance with a further embodiment of the present invention is applied;

FIG. 13 is a timing diagram showing an example of waveforms for programming and driving the pixel circuit of FIG. 12;

FIG. 14 is a diagram showing a pixel circuit to which programming and driving technique in accordance with a further embodiment of the present invention is applied;

FIG. 15 is a timing diagram showing an example of waveforms for programming and driving the pixel circuit of FIG. 14;

FIG. 16 is a diagram showing a display system having the pixel circuit of FIG. 14;

FIG. 17 is a diagram showing a pixel circuit to which programming and driving technique in accordance with a further embodiment of the present invention is applied;

FIG. 18 is a timing diagram showing an example of waveforms for programming and driving the pixel circuit of FIG. 17;

FIG. 19 is a diagram showing a pixel circuit to which programming and driving technique in accordance with a further embodiment of the present invention is applied;

FIG. 20 is a timing diagram showing an example of waveforms for programming and driving the pixel circuit of FIG. 19;

FIG. 21 is a diagram showing a pixel circuit to which programming and driving technique in accordance with a further embodiment of the present invention is applied; and

FIG. 22 is a timing diagram showing an example of waveforms for programming and driving the pixel circuit of FIG. 21;

DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENTS OF THE INVENTION

Embodiments of the present invention are described using a pixel having an organic light emitting diode (OLED) and a driving thin film transistor (TFT). However, the pixel may include any light emitting device other than OLED, and the pixel may include any driving transistor other than TFT. It is noted that in the description, "pixel circuit" and "pixel" may be used interchangeably.

FIG. 2 is a diagram showing programming and driving cycles in accordance with an embodiment of the present invention. In FIG. 2, each of ROW(j), ROW(j+1), and ROW

(j+2) represents a row of the display array where a plurality of pixel circuits are arranged in row and column.

The programming and driving cycle for a frame occurs after the programming and driving cycle for a next frame. The programming and driving cycles for the frame at a ROW overlaps with the programming and driving cycles for the same frame at a next ROW. As described below, during the programming cycle, the time depending parameter(s) of the pixel circuit is extracted to generate a stable pixel current.

FIG. 3 illustrates a pixel circuit 200 to which programming and driving technique in accordance with an embodiment of the present invention is applied. The pixel circuit 200 includes an OLED 20, a storage capacitor 21, a driving transistor 24, and a switch transistor 26. The pixel circuit 200 is a voltage programmed pixel circuit. Each of the transistors 24 and 26 has a gate terminal, a first terminal and a second terminal. In the description, the first terminal (second terminal) may be, but not limited to, a drain terminal or a source terminal (a source terminal or a drain terminal).

The transistors 24 and 26 are n-type TFTs. However, the transistors 24 and 26 may be p-type transistors. As described below, the driving technique applied to the pixel circuit 200 is also applicable to a complementary pixel circuit having p-type transistors as shown in FIG. 14. The transistors 24 and 26 may be fabricated using amorphous silicon, nano/micro crystalline silicon, poly silicon, organic semiconductors technologies (e.g. organic TFT), NMOS/PMOS technology or CMOS technology (e.g. MOSFET).

The first terminal of the driving transistor 24 is connected to a controllable voltage supply line VDD. The second terminal of the driving transistor 24 is connected to the anode electrode of the OLED 20. The gate terminal of the driving transistor 24 is connected to a signal line VDATA through the switch transistor 26. The storage capacitor 21 is connected between the source and gate terminals of the driving transistor 24.

The gate terminal of the switch transistor 26 is connected to a select line SEL. The first terminal of the switch transistor 26 is connected to the signal line VDATA. The second terminal of the switch transistor 26 is connected to the gate terminal of the driving transistor 24. The cathode electrode of the OLED 20 is connected to a ground voltage supply electrode.

The transistors 24 and 26 and the storage capacitor 21 are connected at node A1. The transistor 24, the OLED 20 and the storage capacitor 21 are connected at node B1.

FIG. 4 illustrates a timing diagram showing an example of waveforms for programming and driving the pixel circuit 200 of FIG. 3. Referring to FIGS. 3 and 4, the operation of the pixel circuit 200 includes a programming cycle having three operating cycles X11, X12 and X13, and a driving cycle having one operating cycle X14.

During the programming cycle, node B1 is charged to the negative threshold voltage of the driving transistor 24, and node A1 is charged to a programming voltage VP.

As a result, the gate-source voltage of the driving transistor 24 goes to:

$$V_{GS} = V_P - (-V_T) = V_P + V_T \quad (1)$$

where VGS represents the gate-source voltage of the driving transistor 24, and VT represents the threshold voltage of the driving transistor 24.

Since the driving transistor 24 is in saturation regime of operation, its current is defined mainly by its gate-source voltage. As a result the current of the driving transistor 24 remains constant even if the OLED voltage changes, since its gate-source voltage is stored in the storage capacitor 21.

In the first operating cycle X11: VDD goes to a compensating voltage VCOMPB, and VDATA goes to a high positive compensating voltage VCOMPA, and SEL is high. As a result, node A1 is charged to VCOMPA and node B1 is charged to VCOMPB.

In the second operating cycle X12: While VDATA goes to a reference voltage VREF, node B1 is discharged through the driving transistor 24 until the driving transistor 24 turns off. As a result, the voltage of node B1 reaches (VREF-VT). VDD has a positive voltage VH to increase the speed of this cycle X12. For optimal setting time, VH can be set to be equal to the operating voltage which is the voltage on VDD during the driving cycle.

In the third operating cycle X13: VDD goes to its operating voltage. While SEL is high, node A1 is charged to (VP+VREF). Because the capacitance 22 of the OLED 20 is large, the voltage at node B1 stays at the voltage generated in the previous cycle X12. Thus, the voltage of node B1 is (VREF-VT). Therefore, the gate-source voltage of the driving transistor 24 is (VP+VT), and this gate-source voltage is stored in the storage capacitor 21.

In the fourth operating cycle X14: SEL and VDATA go to zero. VDD is the same as that of the third operating cycle X13. However, VDD may be higher than that of the third operating cycle X13. The voltage stored in the storage capacitor 21 is applied to the gate terminal of the driving transistor 24. Since the gate-source voltage of the driving transistor 24 include its threshold voltage and also is independent of the OLED voltage, the degradation of the OLED 20 and instability of the driving transistor 24 does not affect the amount of current flowing through the driving transistor 24 and the OLED 20.

It is noted that the pixel circuit 200 can be operated with different values of VCOMPB, VCOMPA, VP, VREF and VH. VCOMPB, VCOMPA, VP, VREF and VH define the lifetime of the pixel circuit 200. Thus, these voltages can be defined in accordance with the pixel specifications.

FIG. 5 illustrates a lifetime test result for the pixel circuit and waveform shown in FIGS. 3 and 4. In the test, a fabricated pixel circuit was put under the operation for a long time while the current of the driving transistor (24 of FIG. 3) was monitored to investigate the stability of the driving scheme. The result shows that OLED current is stable after 120-hour operation. The VT shift of the driving transistor is 0.7 V.

FIG. 6 illustrates a display system having the pixel circuit 200 of FIG. 3. VDD1 and VDD2 of FIG. 6 correspond to VDD of FIG. 3. SEL1 and SEL2 of FIG. 6 correspond to SEL of FIG. 3. VDATA1 and VDATA2 of FIG. 6 correspond to VDATA of FIG. 3. The array of FIG. 6 is an active matrix light emitting diode (AMOLED) display having a plurality of the pixel circuits 200 of FIG. 3. The pixel circuits are arranged in rows and columns, and interconnections 41, 42 and 43 (VDATA1, SEL1, VDD1). VDATA1 (or VDATA 2) is shared between the common column pixels while SEL1 (or SEL2) and VDD1 (or VDD2) are shared between common row pixels in the array structure.

A driver 300 is provided for driving VDATA1 and VDATA2. A driver 302 is provided for driving VDD1, VDD2, SEL1 and SEL 2, however, the driver for VDD and SEL lines can also be implemented separately. A controller 304 controls the drivers 300 and 302 to programming and driving the pixel circuits as described above. The timing diagram for programming and driving the display array of FIG. 6 is as shown in FIG. 2. Each programming and driving cycle may be the same as that of FIG. 4.

FIG. 7(a) illustrates an example of array structure having top emission pixels are arranged. FIG. 7(b) illustrates an example of array structure having bottom emission pixels are

arranged. The array of FIG. 6 may have array structure shown in FIG. 7(a) or 7(b). In FIG. 7(a), 400 represents a substrate, 402 represents a pixel contact, 403 represents a (top emission) pixel circuit, and 404 represents a transparent top electrode on the OLEDs. In FIG. 7(b), 410 represents a transparent substrate, 411 represents a (bottom emission) pixel circuit, and 412 represents a top electrode. All of the pixel circuits including the TFTs, the storage capacitor, the SEL, VDATA, and VDD lines are fabricated together. After that, the OLEDs are fabricated for all pixel circuits. The OLED is connected to the corresponding driving transistor using a via (e.g. B1 of FIG. 3) as shown in FIGS. 7(a) and 7(b). The panel is finished by deposition of the top electrode on the OLEDs which can be a continuous layer, reducing the complexity of the design and can be used to turn the entire display ON/OFF or control the brightness.

FIG. 8 illustrates a pixel circuit 202 to which programming and driving technique in accordance with a further embodiment of the present invention is applied. The pixel circuit 202 includes an OLED 50, two storage capacitors 52 and 53, a driving transistor 54, and switch transistors 56 and 58. The pixel circuit 202 is a top emission, voltage programmed pixel circuit. This embodiment principally works in the same manner as that of FIG. 3. However, in the pixel circuit 202, the OLED 50 is connected to the drain terminal of the driving transistor 54. As a result, the circuit can be connected to the cathode of the OLED 50. Thus, the OLED deposition can be started with the cathode.

The transistors 54, 56 and 58 are n-type TFTs. However, the transistors 54, 56 and 58 may be p-type transistors. The driving technique applied to the pixel circuit 202 is also applicable to a complementary pixel circuit having p-type transistors as shown in FIG. 17. The transistors 54, 56 and 58 may be fabricated using amorphous silicon, nano/micro crystalline silicon, poly silicon, organic semiconductors technologies (e.g. organic TFT), NMOS/PMOS technology or CMOS technology (e.g. MOSFET).

The first terminal of the driving transistor 54 is connected to the cathode electrode of the OLED 50. The second terminal of the driving transistor 54 is connected to a controllable voltage supply line VSS. The gate terminal of the driving transistor 54 is connected to its first line (terminal) through the switch transistor 56. The storage capacitors 52 and 53 are in series, and are connected between the gate terminal of the driving transistor 54 and a common ground. The voltage on the voltage supply line VSS is controllable. The common ground may be connected to VSS.

The gate terminal of the switch transistor 56 is connected to a first select line SEL1. The first terminal of the switch transistor 56 is connected to the drain terminal of the driving transistor 54. The second terminal of the switch transistor 56 is connected to the gate terminal of the driving transistor 54.

The gate terminal of the switch transistor 58 is connected to a second select line SEL2. The first terminal of the switch transistor 58 is connected to a signal line VDATA. The second terminal of the switch transistor 58 is connected to the shared terminal of the storage capacitors 52 and 53 (i.e. node C2). The anode electrode of the OLED 50 is connected to a voltage supply electrode VDD.

The OLED 50 and the transistors 54 and 56 are connected at node A2. The storage capacitor 52 and the transistors 54 and 56 are connected at node B2.

FIG. 9 illustrates a timing diagram showing an example of waveforms for programming and driving the pixel circuit 202 of FIG. 8. Referring to FIGS. 8 and 9, the operation of the pixel circuit 202 includes a programming cycle having four

operating cycles X21, X22, X23 and X24, and a driving cycle having one operating cycle X25.

During the programming cycle, a programming voltage plus the threshold voltage of the driving transistor 54 is stored in the storage capacitor 52. The source terminal of the driving transistor 54 goes to zero, and the second storage capacitor 53 is charged to zero.

As a result, the gate-source voltage of the driving transistor 54 goes to:

$$V_{GS}=V_P+V_T \quad (2)$$

where VGS represents the gate-source voltage of the driving transistor 54, VP represents the programming voltage, and VT represents the threshold voltage of the driving transistor 54.

In the first operating cycle X21: VSS goes to a high positive voltage, and VDATA is zero. SEL1 and SEL2 are high. Therefore, nodes A2 and B2 are charged to a positive voltage.

In the second operating cycle X22: While SEL1 is low and the switch transistor 56 is off, VDATA goes to a high positive voltage. As a result, the voltage at node B2 increases (i.e. bootstrapping) and node A2 is charged to the voltage of VSS. At this voltage, the OLED 50 is off.

In the third operating cycle X23: VSS goes to a reference voltage VREF. VDATA goes to (VREF-VP). At the beginning of this cycle, the voltage of node B2 becomes almost equal to the voltage of node A2 because the capacitance 51 of the OLED 50 is bigger than that of the storage capacitor 52. After that, the voltage of node B2 and the voltage of node A2 are discharged through the driving transistor 54 until the driving transistor 54 turns off. As a result, the gate-source voltage of the driving transistor 54 is (VREF+VT), and the voltage stored in storage capacitor 52 is (VP+VT).

In the fourth operating cycle X24: SEL1 is low. Since SEL2 is high, and VDATA is zero, the voltage at node C2 goes to zero.

In the fifth operating cycle X25: VSS goes to its operating voltage during the driving cycle. In FIG. 5, the operating voltage of VSS is zero. However, it may be any voltage other than zero. SEL2 is low. The voltage stored in the storage capacitor 52 is applied to the gate terminal of the driving transistor 54. Accordingly, a current independent of the threshold voltage VT of the driving transistor 54 and the voltage of the OLED 50 flows through the driving transistor 54 and the OLED 50. Thus, the degradation of the OLED 50 and instability of the driving transistor 54 does not affect the amount of the current flowing through the driving transistor 54 and the OLED 50.

FIG. 10 illustrates a pixel circuit 204 to which programming and driving technique in accordance with a further embodiment of the present invention is applied. The pixel circuit 204 includes an OLED 60, two storage capacitors 62 and 63, a driving transistor 64, and switch transistors 66 and 68. The pixel circuit 204 is a top emission, voltage programmed pixel circuit. The pixel circuit 204 principally works similar to that of in FIG. 8. However, one common select line is used to operate the pixel circuit 204, which can increase the available pixel area and aperture ratio.

The transistors 64, 66 and 68 are n-type TFTs. However, The transistors 64, 66 and 68 may be p-type transistors. The driving technique applied to the pixel circuit 204 is also applicable to a complementary pixel circuit having p-type transistors as shown in FIG. 19. The transistors 64, 66 and 68 may be fabricated using amorphous silicon, nano/micro crystalline silicon, poly silicon, organic semiconductors technologies (e.g. organic TFT), NMOS/PMOS technology or CMOS technology (e.g. MOSFET).

The first terminal of the driving transistor 64 is connected to the cathode electrode of the OLED 60. The second terminal of the driving transistor 64 is connected to a controllable voltage supply line VSS. The gate terminal of the driving transistor 64 is connected to its first line (terminal) through the switch transistor 66. The storage capacitors 62 and 63 are in series, and are connected between the gate terminal of the driving transistor 64 and the common ground. The voltage of the voltage supply line VSS is controllable. The common ground may be connected to VSS.

The gate terminal of the switch transistor 66 is connected to a select line SEL. The first terminal of the switch transistor 66 is connected to the first terminal of the driving transistor 64. The second terminal of the switch transistor 66 is connected to the gate terminal of the driving transistor 64.

The gate terminal of the switch transistor 68 is connected to the select line SEL. The first terminal of the switch transistor 68 is connected to a signal line VDATA. The second terminal of the switch transistor 68 is connected to the shared terminal of storage capacitors 62 and 63 (i.e. node C3). The anode electrode of the OLED 60 is connected to a voltage supply electrode VDD.

The OLED 60 and the transistors 64 and 66 are connected at node A3. The storage capacitor 62 and the transistors 64 and 66 are connected at node B3.

FIG. 11 illustrates a timing diagram showing an example of waveforms for programming and driving the pixel circuit 204 of FIG. 10. Referring to FIGS. 10 and 11, the operation of the pixel circuit 204 includes a programming cycle having three operating cycles X31, X32 and X33, and a driving cycle includes one operating cycle X34.

During the programming cycle, a programming voltage plus the threshold voltage of the driving transistor 64 is stored in the storage capacitor 62. The source terminal of the driving transistor 64 goes to zero and the storage capacitor 63 is charged to zero.

As a result, the gate-source voltage of the driving transistor 64 goes to:

$$V_{GS}=V_P+V_T \quad (3)$$

where VGS represents the gate-source voltage of the driving transistor 64, VP represents the programming voltage, and VT represents the threshold voltage of the driving transistor 64.

In the first operating cycle X31: VSS goes to a high positive voltage, and VDATA is zero. SEL is high. As a result, nodes A3 and B3 are charged to a positive voltage. The OLED 60 turns off.

In the second operating cycle X32: While SEL is high, VSS goes to a reference voltage VREF. VDATA goes to (VREF-VP). As a result, the voltage at node B3 and the voltage of node A3 are discharged through the driving transistor 64 until the driving transistor 64 turns off. The voltage of node B3 is (VREF+VT), and the voltage stored in the storage capacitor 62 is (VP+VT).

In the third operating cycle X33: SEL goes to VM. VM is an intermediate voltage in which the switch transistor 66 is off and the switch transistor 68 is on. VDATA goes to zero. Since SEL is VM and VDATA is zero, the voltage of node C3 goes to zero.

VM is defined as:

$$V_{T3}<VM<V_{REF}+V_{T1}+V_{T2} \quad (a)$$

where VT1 represents the threshold voltage of the driving transistor 64, VT2 represents the threshold voltage of the switch transistor 66, and VT3 represents the threshold voltage of the switch transistor 68.

The condition (a) forces the switch transistor **66** to be off and the switch transistor **68** to be on. The voltage stored in the storage capacitor **62** remains intact.

In the fourth operating cycle **X34**: VSS goes to its operating voltage during the driving cycle. In FIG. **11**, the operating voltage of VSS is zero. However, the operating voltage of VSS may be any voltage other than zero. SEL is low. The voltage stored in the storage capacitor **62** is applied to the gate of the driving transistor **64**. The driving transistor **64** is ON. Accordingly, a current independent of the threshold voltage V_T of the driving transistor **64** and the voltage of the OLED **60** flows through the driving transistor **64** and the OLED **60**. Thus, the degradation of the OLED **60** and instability of the driving transistor **64** does not affect the amount of the current flowing through the driving transistor **64** and the OLED **60**.

FIG. **12** illustrates a pixel circuit **206** to which programming and driving technique in accordance with a further embodiment of the present invention is applied. The pixel circuit **206** includes an OLED **70**, two storage capacitors **72** and **73**, a driving transistor **74**, and switch transistors **76** and **78**. The pixel circuit **206** is a top emission, voltage programmed pixel circuit.

The transistors **74**, **76** and **78** are n-type TFTs. However, the transistors **74**, **76** and **78** may be p-type transistors. The driving technique applied to the pixel circuit **206** is also applicable to a complementary pixel circuit having p-type transistors as shown in FIG. **21**. The transistors **74**, **76** and **78** may be fabricated using amorphous silicon, nano/micro crystalline silicon, poly silicon, organic semiconductors technologies (e.g. organic TFT), NMOS/PMOS technology or CMOS technology (e.g. MOSFET).

The first terminal of the driving transistor **74** is connected to the cathode electrode of the OLED **70**. The second terminal of the driving transistor **74** is connected to a common ground. The gate terminal of the driving transistor **74** is connected to its first line (terminal) through the switch transistor **76**. The storage capacitors **72** and **73** are in series, and are connected between the gate terminal of the driving transistor **74** and the common ground.

The gate terminal of the switch transistor **76** is connected to a select line SEL. The first terminal of the switch transistor **76** is connected to the first terminal of the driving transistor **74**. The second terminal of the switch transistor **76** is connected to the gate terminal of the driving transistor **74**.

The gate terminal of the switch transistor **78** is connected to the select line SEL. The first terminal of the switch transistor **78** is connected to a signal line VDATA. The second terminal is connected to the shared terminal of storage capacitors **72** and **73** (i.e. node C4). The anode electrode of the OLED **70** is connected to a voltage supply electrode VDD. The voltage of the voltage electrode VDD is controllable.

The OLED **70** and the transistors **74** and **76** are connected at node A4. The storage capacitor **72** and the transistors **74** and **76** are connected at node B4.

FIG. **13** illustrates a timing diagram showing an example of waveforms for programming and driving the pixel circuit **206** of FIG. **12**. Referring to FIGS. **12** and **13**, the operation of the pixel circuit **206** includes a programming cycle having four operating cycles **X41**, **X42**, **X43** and **X44**, and a driving cycle having one driving cycle **45**.

During the programming cycle, a programming voltage plus the threshold voltage of the driving transistor **74** is stored in the storage capacitor **72**. The source terminal of the driving transistor **74** goes to zero and the storage capacitor **73** is charged to zero.

As a result, the gate-source voltage of the driving transistor **74** goes to:

$$V_{GS} = V_P + V_T \quad (4)$$

where V_{GS} represents the gate-source voltage of the driving transistor **74**, V_P represents the programming voltage, and V_T represents the threshold voltage of the driving transistor **74**.

In the first operating cycle **X41**: SEL is high. VDATA goes to a low voltage. While VDD is high, node B4 and node A4 are charged to a positive voltage.

In the second operating cycle **X42**: SEL is low, and VDD goes to a reference voltage V_{REF} where the OLED **70** is off.

In the third operating cycle **X43**: VDATA goes to ($V_{REF2} - V_P$) where V_{REF2} is a reference voltage. It is assumed that V_{REF2} is zero. However, V_{REF2} can be any voltage other than zero. SEL is high. Therefore, the voltage of node B4 and the voltage of node A4 become equal at the beginning of this cycle. It is noted that the first storage capacitor **72** is large enough so that its voltage becomes dominant. After that, node B4 is discharged through the driving transistor **74** until the driving transistor **74** turns off.

As a result, the voltage of node B4 is V_T (i.e. the threshold voltage of the driving transistor **74**). The voltage stored in the first storage capacitor **72** is $(V_P - V_{REF2} + V_T) = (V_P + V_T)$ where $V_{REF2} = 0$.

In the fourth operating cycle **X44**: SEL goes to VM where VM is an intermediate voltage at which the switch transistor **76** is off and the switch transistor **78** is on. VM satisfies the following condition:

$$V_{T3} < V_M < V_P + V_T \quad (b)$$

where V_{T3} represents the threshold voltage of the switch transistor **78**.

VDATA goes to V_{REF2} ($=0$). The voltage of node C4 goes to V_{REF2} ($=0$).

This results in that the gate-source voltage V_{GS} of the driving transistor **74** is $(V_P + V_T)$. Since $V_M < V_P + V_T$, the switch transistor **76** is off, and the voltage stored in the storage capacitor **72** stays at $V_P + V_T$.

In the fifth operating cycle **X45**: VDD goes to the operating voltage. SEL is low. The voltage stored in the storage capacitor **72** is applied to the gate of the driving transistor **74**. Accordingly, a current independent of the threshold voltage V_T of the driving transistor **74** and the voltage of the OLED **70** flows through the driving transistor **74** and the OLED **70**. Thus, the degradation of the OLED **70** and instability of the driving transistor **74** does not affect the amount of the current flowing through the driving transistor **74** and the OLED **70**.

FIG. **14** illustrates a pixel circuit **208** to which programming and driving technique in accordance with a further embodiment of the present invention is applied. The pixel circuit **208** includes an OLED **80**, a storage capacitor **81**, a driving transistor **84** and a switch transistor **86**. The pixel circuit **208** corresponds to the pixel circuit **200** of FIG. **3**, and a voltage programmed pixel circuit.

The transistors **84** and **86** are p-type TFTs. The transistors **84** and **86** may be fabricated using amorphous silicon, nano/micro crystalline silicon, poly silicon, organic semiconductors technologies (e.g. organic TFT), CMOS technology (e.g. MOSFET) and any other technology which provides p-type transistors.

The first terminal of the driving transistor **84** is connected to a controllable voltage supply line VSS. The second terminal of the driving transistor **84** is connected to the cathode electrode of the OLED **80**. The gate terminal of the driving transistor **84** is connected to a signal line VDATA through the

switch transistor **86**. The storage capacitor **81** is connected between the second terminal and the gate terminal of the driving transistor **84**.

The gate terminal of the switch transistor **86** is connected to a select line SEL. The first terminal of the switch transistor **86** is connected to the signal line VDATA. The second terminal of the switch transistor **86** is connected to the gate terminal of the driving transistor **84**. The anode electrode of the OLED **80** is connected to a ground voltage supply electrode.

The storage capacitor **81** and the transistors **84** and **85** are connected at node A5. The OLED **80**, the storage capacitor **81** and the driving transistor **84** are connected at node B5.

FIG. 15 illustrates a timing diagram showing an example of waveforms for programming and driving the pixel circuit **208** of Figure. FIG. 15 corresponds to FIG. 4. VDATA and VSS are used to programming and compensating for a time dependent parameter of the pixel circuit **208**, which are similar to VDATA and VDD of FIG. 4. Referring to FIGS. 14 and 15, the operation of the pixel circuit **208** includes a programming cycle having three operating cycles X51, X52 and X53, and a driving cycle having one operating cycle X54.

During the programming cycle, node B5 is charged to a positive threshold voltage of the driving transistor **84**, and node A5 is charged to a negative programming voltage.

As a result, the gate-source voltage of the driving transistor **84** goes to:

$$V_{GS} = -VP + (-|VT|) = -VP - |VT| \quad (5)$$

where VGS represents the gate-source voltage of the driving transistor **84**, VP represents the programming voltage, and VT represents the threshold voltage of the driving transistor **84**.

In the first operating cycle X51: VSS goes to a positive compensating voltage VCOMPB, and VDATA goes to a negative compensating voltage (-VCOMPA), and SEL is low. As a result, the switch transistor **86** is on. Node A5 is charged to (-VCOMPA). Node B5 is charged to VCOMPB.

In the second operating cycle X52: VDATA goes to a reference voltage VREF. Node B5 is discharged through the driving transistor **84** until the driving transistor **84** turns off. As a result, the voltage of node B5 reaches VREF+|VT|. VSS goes to a negative voltage VL to increase the speed of this cycle X52. For the optimal setting time, VL is selected to be equal to the operating voltage which is the voltage of VSS during the driving cycle.

In the third operating cycle X53: While VSS is in the VL level, and SEL is low, node A5 is charged to (VREF-VP). Because the capacitance **82** of the OLED **80** is large, the voltage of node B5 stays at the positive threshold voltage of the driving transistor **84**. Therefore, the gate-source voltage of the driving transistor **84** is (-VP-|VT|), which is stored in storage capacitor **81**.

In the fourth operating cycle X54: SEL and VDATA go to zero. VSS goes to a high negative voltage (i.e. its operating voltage). The voltage stored in the storage capacitor **81** is applied to the gate terminal of the driving transistor **84**. Accordingly, a current independent of the voltage of the OLED **80** and the threshold voltage of the driving transistor **84** flows through the driving transistor **84** and the OLED **80**. Thus, the degradation of the OLED **80** and instability of the driving transistor **84** does not affect the amount of the current flowing through the driving transistor **84** and the OLED **80**.

It is noted that the pixel circuit **208** can be operated with different values of VCOMPB, VCOMPA, VL, VREF and VP. VCOMPB, VCOMPA, VL, VREF and VP define the lifetime of the pixel circuit. Thus, these voltages can be defined in accordance with the pixel specifications.

FIG. 16 illustrates a display system having the pixel circuit **208** of FIG. 14. VSS1 and VSS2 of FIG. 16 correspond to VSS of FIG. 14. SEL1 and SEL2 of FIG. 16 correspond to SEL of FIG. 14. VDATA1 and VDATA2 of FIG. 16 correspond to VDATA of FIG. 14. The array of FIG. 16 is an active matrix light emitting diode (AMOLED) display having a plurality of the pixel circuits **208** of FIG. 14. The pixel circuits **208** are arranged in rows and columns, and interconnections **91**, **92** and **93** (VDATA1, SEL2, VSS2). VDATA1 (or VDATA2) is shared between the common column pixels while SEL1 (or SEL2) and VSS1 (or VSS2) are shared between common row pixels in the array structure.

A driver **310** is provided for driving VDATA1 and VDATA2. A driver **312** is provided for driving VSS1, VSS2, SEL1 and SEL2. A controller **314** controls the drivers **310** and **312** to implement the programming and driving cycles described above. The timing diagram for programming and driving the display array of FIG. 6 is as shown in FIG. 2. Each programming and driving cycle may be the same as that of FIG. 15.

The array of FIG. 16 may have array structure shown in FIG. 7(a) or 7(b). The array of FIG. 16, is produced in a manner similar to that of FIG. 6. All of the pixel circuits including the TFTs, the storage capacitor, the SEL, VDATA, and VSS lines are fabricated together. After that, the OLEDs are fabricated for all pixel circuits. The OLED is connected to the corresponding driving transistor using a via (e.g. B5 of FIG. 14). The panel is finished by deposition of the top electrode on the OLEDs which can be a continuous layer, reducing the complexity of the design and can be used to turn the entire display ON/OFF or control the brightness.

FIG. 17 illustrates a pixel circuit **210** to which programming and driving technique in accordance with a further embodiment of the present invention is applied. The pixel circuit **210** includes an OLED **100**, two storage capacitors **102** and **103**, a driving transistor **104**, and switch transistors **106** and **108**. The pixel circuit **210** corresponds to the pixel circuit **202** of FIG. 8.

The transistors **104**, **106** and **108** are p-type TFTs. The transistors **84** and **86** may be fabricated using amorphous silicon, nano/micro crystalline silicon, poly silicon, organic semiconductors technologies (e.g. organic TFT), CMOS technology (e.g. MOSFET) and any other technology which provides p-type transistors.

In FIG. 17, one of the terminals of the driving transistor **104** is connected to the anode electrode of the OLED **100**, while the other terminal is connected to a controllable voltage supply line VDD. The storage capacitors **102** and **103** are in series, and are connected between the gate terminal of the driving transistor **104** and a voltage supply electrode V2. Also, V2 may be connected to VDD. The cathode electrode of the OLED **100** is connected to a ground voltage supply electrode.

The OLED **100** and the transistors **104** and **106** are connected at node A6. The storage capacitor **102** and the transistors **104** and **106** are connected at node B6. The transistor **108** and the storage capacitors **102** and **103** are connected at node C6.

FIG. 18 illustrates a timing diagram showing an example of waveforms for programming and driving the pixel circuit **210** of FIG. 17. FIG. 18 corresponds to FIG. 9. VDATA and VDD are used to programming and compensating for a time dependent parameter of the pixel circuit **210**, which are similar to VDATA and VSS of FIG. 9. Referring to FIGS. 17 and 18, the operation of the pixel circuit **210** includes a programming cycle having four operating cycles X61, X62, X63 and X64, and a driving cycle having one operating cycle X65.

During the programming cycle, a negative programming voltage plus the negative threshold voltage of the driving transistor **104** is stored in the storage capacitor **102**, and the second storage capacitor **103** is discharged to zero.

As a result, the gate-source voltage of the driving transistor **104** goes to:

$$V_{GS} = -VP - |VT| \quad (6)$$

where V_{GS} represents the gate-source voltage of the driving transistor **104**, VP represents the programming voltage, and VT represents the threshold voltage of the driving transistor **104**.

In the first operating cycle **X61**: V_{DD} goes to a high negative voltage, and V_{DATA} is set to V_2 . SEL_1 and SEL_2 are low. Therefore, nodes **A6** and **B6** are charged to a negative voltage.

In the second operating cycle **X62**: While SEL_1 is high and the switch transistor **106** is off, V_{DATA} goes to a negative voltage. As a result, the voltage at node **B6** decreases, and the voltage of node **A6** is charged to the voltage of V_{DD} . At this voltage, the OLED **100** is off.

In the third operating cycle **X63**: V_{DD} goes to a reference voltage V_{REF} . V_{DATA} goes to $(V_2 - V_{REF} + VP)$ where V_{REF} is a reference voltage. It is assumed that V_{REF} is zero. However, V_{REF} may be any voltage other than zero. At the beginning of this cycle, the voltage of node **B6** becomes almost equal to the voltage of node **A6** because the capacitance **101** of the OLED **100** is bigger than that of the storage capacitor **102**. After that, the voltage of node **B6** and the voltage of node **A6** are charged through the driving transistor **104** until the driving transistor **104** turns off. As a result, the gate-source voltage of the driving transistor **104** is $(-VP - |VT|)$, which is stored in the storage capacitor **102**.

In the fourth operating cycle **X64**: SEL_1 is high. Since SEL_2 is low, and V_{DATA} goes to V_2 , the voltage at node **C6** goes to V_2 .

In the fifth operating cycle **X65**: V_{DD} goes to its operating voltage during the driving cycle. In FIG. **18**, the operating voltage of V_{DD} is zero. However, the operating voltage of V_{DD} may be any voltage. SEL_2 is high. The voltage stored in the storage capacitor **102** is applied to the gate terminal of the driving transistor **104**. Thus, a current independent of the threshold voltage VT of the driving transistor **104** and the voltage of the OLED **100** flows through the driving transistor **104** and the OLED **100**. Accordingly, the degradation of the OLED **100** and instability of the driving transistor **104** do not affect the amount of the current flowing through the driving transistor **54** and the OLED **100**.

FIG. **19** illustrates a pixel circuit **212** to which programming and driving technique in accordance with a further embodiment of the present invention is applied. The pixel circuit **212** includes an OLED **110**, two storage capacitors **112** and **113**, a driving transistor **114**, and switch transistors **116** and **118**. The pixel circuit **212** corresponds to the pixel circuit **204** of FIG. **10**.

The transistors **114**, **116** and **118** are p-type TFTs. The transistors **84** and **86** may be fabricated using amorphous silicon, nano/micro crystalline silicon, poly silicon, organic semiconductors technologies (e.g. organic TFT), CMOS technology (e.g. MOSFET) and any other technology which provides p-type transistors.

In FIG. **19**, one of the terminals of the driving transistor **114** is connected to the anode electrode of the OLED **110**, while the other terminal is connected to a controllable voltage supply line V_{DD} . The storage capacitors **112** and **113** are in series, and are connected between the gate terminal of the driving transistor **114** and a voltage supply electrode V_2 .

Also, V_2 may be connected to V_{DD} . The cathode electrode of the OLED **110** is connected to a ground voltage supply electrode.

The OLED **110** and the transistors **114** and **116** are connected at node **A7**. The storage capacitor **112** and the transistors **114** and **116** are connected at node **B7**. The transistor **118** and the storage capacitors **112** and **113** are connected at node **C7**.

FIG. **20** illustrates a timing diagram showing an example of waveforms for programming and driving the pixel circuit **212** of FIG. **19**. FIG. **20** corresponds to FIG. **11**. V_{DATA} and V_{DD} are used to programming and compensating for a time dependent parameter of the pixel circuit **212**, which are similar to V_{DATA} and V_{SS} of FIG. **11**. Referring to FIGS. **19** and **20**, the operation of the pixel circuit **212** includes a programming cycle having four operating cycles **X71**, **X72** and **X73**, and a driving cycle having one operating cycle **X74**.

During the programming cycle, a negative programming voltage plus the negative threshold voltage of the driving transistor **114** is stored in the storage capacitor **112**. The storage capacitor **113** is discharged to zero.

As a result, the gate-source voltage of the driving transistor **114** goes to:

$$V_{GS} = -VP - |VT| \quad (7)$$

where V_{GS} represents the gate-source voltage of the driving transistor **114**, VP represents the programming voltage, and VT represents the threshold voltage of the driving transistor **114**.

In the first operating cycle **X71**: V_{DD} goes to a negative voltage. SEL is low. Node **A7** and node **B7** are charged to a negative voltage.

In the second operating cycle **X72**: V_{DD} goes to a reference voltage V_{REF} . V_{DATA} goes to $(V_2 - V_{REF} + VP)$. The voltage at node **B7** and the voltage of node **A7** are changed until the driving transistor **114** turns off. The voltage of **B7** is $(-V_{REF} - VT)$, and the voltage stored in the storage capacitor **112** is $(-VP - |VT|)$.

In the third operating cycle **X73**: SEL goes to VM . VM is an intermediate voltage in which the switch transistor **106** is off and the switch transistor **118** is on. V_{DATA} goes to V_2 . The voltage of node **C7** goes to V_2 . The voltage stored in the storage capacitor **112** is the same as that of **X72**.

In the fourth operating cycle **X74**: V_{DD} goes to its operating voltage. SEL is high. The voltage stored in the storage capacitor **112** is applied to the gate of the driving transistor **114**. The driving transistor **114** is on. Accordingly, a current independent of the threshold voltage VT of the driving transistor **114** and the voltage of the OLED **110** flows through the driving transistor **114** and the OLED **110**.

FIG. **21** illustrates a pixel circuit **214** to which programming and driving technique in accordance with a further embodiment of the present invention is applied. The pixel circuit **214** includes an OLED **120**, two storage capacitors **122** and **123**, a driving transistor **124**, and switch transistors **126** and **128**. The pixel circuit **212** corresponds to the pixel circuit **206** of FIG. **12**.

The transistors **124**, **126** and **128** are p-type TFTs. The transistors **84** and **86** may be fabricated using amorphous silicon, nano/micro crystalline silicon, poly silicon, organic semiconductors technologies (e.g. organic TFT), CMOS technology (e.g. MOSFET) and any other technology which provides p-type transistors.

In FIG. **21**, one of the terminals of the driving transistor **124** is connected to the anode electrode of the OLED **120**, while the other terminal is connected to a voltage supply line V_{DD} . The storage capacitors **122** and **123** are in series, and are

connected between the gate terminal of the driving transistor **124** and VDD. The cathode electrode of the OLED **120** is connected to a controllable voltage supply electrode VSS.

The OLED **120** and the transistors **124** and **126** are connected at node A8. The storage capacitor **122** and the transistors **124** and **126** are connected at node B8. The transistor **128** and the storage capacitors **122** and **123** are connected at node C8.

FIG. **22** illustrates a timing diagram showing an example of waveforms for programming and driving the pixel circuit **214** of FIG. **21**. FIG. **22** corresponds to FIG. **13**. VDATA and VSS are used to programming and compensating for a time dependent parameter of the pixel circuit **214**, which are similar to VDATA and VDD of FIG. **13**. Referring to FIGS. **21** and **22**, the programming of the pixel circuit **214** includes a programming cycle having four operating cycles X81, X82, X83 and X84, and a driving cycle having one driving cycle X85.

During the programming cycle, a negative programming voltage plus the negative threshold voltage of the driving transistor **124** is stored in the storage capacitor **122**. The storage capacitor **123** is discharged to zero.

As a result, the gate-source voltage of the driving transistor **124** goes to:

$$VGS = -VP - |VT|(8)$$

where VGS represents the gate-source voltage of the driving transistor **114**, VP represents the programming voltage, and VT represents the threshold voltage of the driving transistor **124**.

In the first operating cycle X81: VDATA goes to a high voltage. SEL is low. Node A8 and node B8 are charged to a positive voltage.

In the second operating cycle X82: SEL is high. VSS goes to a reference voltage VREF1 where the OLED **60** is off.

In the third operating cycle X83: VDATA goes to (VREF2+VP) where VREF2 is a reference voltage. SEL is low. Therefore, the voltage of node B8 and the voltage of node A8 become equal at the beginning of this cycle. It is noted that the first storage capacitor **112** is large enough so that its voltage becomes dominant. After that, node B8 is charged through the driving transistor **124** until the driving transistor **124** turns off. As a result, the voltage of node B8 is (VDD-|VT|). The voltage stored in the first storage capacitor **122** is (-VREF2-VP-|VT|).

In the fourth operating cycle X84: SEL goes to VM where VM is an intermediate voltage at which the switch transistor **126** is off and the switch transistor **128** is on. VDATA goes to VREF2. The voltage of node C8 goes to VREF2.

This results in that the gate-source voltage VGS of the driving transistor **124** is (-VP-|VT|). Since VM<-VP-VT, the switch transistor **126** is off, and the voltage stored in the storage capacitor **122** stays at -(VP+|VT|).

In the fifth operating cycle X85: VSS goes to the operating voltage. SEL is low. The voltage stored in the storage capacitor **122** is applied to the gate of the driving transistor **124**.

It is noted that a system for operating an array having the pixel circuit of FIG. **8**, **10**, **12**, **17**, **19** or **21** may be similar to that of FIG. **6** or **16**. The array having the pixel circuit of FIG. **8**, **10**, **12**, **17**, **19** or **21** may have array structure shown in FIG. **7(a)** or **7(b)**.

It is noted that each transistor can be replaced with p-type or n-type transistor based on concept of complementary circuits.

According to the embodiments of the present invention, the driving transistor is in saturation regime of operation. Thus, its current is defined mainly by its gate-source voltage VGS. As a result, the current of the driving transistor remains con-

stant even if the OLED voltage changes since its gate-source voltage is stored in the storage capacitor.

According to the embodiments of the present invention, the overdrive voltage providing to a driving transistor is generated by applying a waveform independent of the threshold voltage of the driving transistor and/or the voltage of a light emitting diode voltage.

According to the embodiments of the present invention, a stable driving technique based on bootstrapping is provided (e.g. FIGS. **2-12** and **16-20**).

The shift(s) of the characteristic(s) of a pixel element(s) (e.g. the threshold voltage shift of a driving transistor and the degradation of a light emitting device under prolonged display operation) is compensated for by voltage stored in a storage capacitor and applying it to the gate of the driving transistor. Thus, the pixel circuit can provide a stable current though the light emitting device without any effect of the shifts, which improves the display operating lifetime. Moreover, because of the circuit simplicity, it ensures higher product yield, lower fabrication cost and higher resolution than conventional pixel circuits.

All citations are hereby incorporated by reference.

The present invention has been described with regard to one or more embodiments. However, it will be apparent to persons skilled in the art that a number of variations and modifications can be made without departing from the scope of the invention as defined in the claims.

What is claimed is:

1. A display system comprising:

a pixel circuit including a drive transistor, a storage capacitor, one or more switch transistors, and a light emitting device, the drive transistor having a terminal connected to the light emitting device, the drive transistor having a threshold voltage that shifts during operation of the drive transistor;

a controllable power supply connected to a terminal of the drive transistor other than the one connected to the light emitting device for supplying the pixel circuit with a compensating voltage or with an operating voltage;

a voltage driver for supplying a programming voltage to the pixel circuit via the one or more switch transistors along a data line so as to program the pixel circuit to emit light according to display information; and

a controller configured to operate the controllable power supply, the voltage driver, and one or more select lines that control the one or more switch transistors, such that: in response to one of the one or more select lines being activated, the compensating voltage is applied to the light emitting device, via the drive transistor, to turn off the light emitting device,

in response to applying the compensation voltage, setting the data line to a nonzero reference voltage,

responsive to setting the data line to the nonzero reference voltage, the storage capacitor is allowed to charge or discharge, through the drive transistor, until the drive transistor turns off, while the one of the one or more select lines remain activated such that the threshold voltage of the drive transistor is established across the drive transistor,

the programming voltage is applied to the pixel circuit, thereby establishing a fixed voltage across the drive transistor that accounts for instabilities in the threshold voltage of the drive transistor; and

wherein the controller is configured to operate the pixel circuit to maintain the fixed voltage across the drive transistor on the storage capacitor while turning on the operating voltage during a driving cycle of the

pixel circuit, the driving cycle being separate from a programming cycle during which the fixed voltage is established on the storage capacitor.

2. The display system of claim 1, in which the controllable power supply maintains a substantially constant pixel current as the threshold voltage of the drive transistor changes with the aging of the drive transistor.

3. The display system of claim 2, in which the light emitting device includes an organic light emitting diode supplied with the stable pixel current from the drive transistor, and the stable pixel current maintains a substantially constant brightness of the light emitted by the organic light emitting diode.

4. The display system of claim 1, in which the pixel circuit includes an organic light emitting diode having an operating voltage that increases as the organic light emitting diode ages.

5. The display system of claim 1, wherein the pixel circuit is configured to receive, via a first one of the one or more switch transistors coupled to a data line, a reference voltage applied to a gate terminal of the drive transistor, while a storage capacitor coupled across the drive transistor is allowed to charge or discharge through the drive transistor until the drive transistor turns off, thereby establishing the threshold voltage of the drive transistor across the drive transistor, the reference voltage being generated on the data line by the voltage driver.

6. The display system of claim 5, wherein the pixel circuit is further configured to receive, via the first switch transistor coupled to the data line, the programming voltage applied to the gate terminal of the drive transistor thereby establishing a fixed voltage on the storage capacitor coupled across the drive transistor, the fixed voltage being a voltage based on the threshold voltage of the drive transistor and the programming voltage.

7. The display system of claim 1, wherein the pixel circuit is configured with the storage capacitor connected across a gate terminal of the drive transistor and the terminal of the drive transistor connected to the light emitting device, and wherein the one or more switch transistors includes a first switch transistor operated by a first select line to selectively connect the gate terminal of the drive transistor to a data line via the first switch transistor.

8. The display system of claim 1, wherein the controller is configured to apply the compensating voltage from the controllable power supply to the light emitting device via the drive transistor so as to turn off the light emitting device during the programming cycle, the controller being further configured to adjust the controllable power supply to the operating voltage during the driving cycle.

9. The display system of claim 1, wherein the pixel circuit is one of a plurality of pixel circuits arranged in rows and columns to form an active matrix display array, each of the plurality of pixel circuits configured to be similarly operated by the controller so as to establish a fixed voltage across the respective drive transistors of the plurality of pixel circuits that accounts for instabilities in the threshold voltages of the respective drive transistors.

10. The display system of claim 1, wherein the light emitting device includes an organic light emitting diode and wherein at least one of the drive transistor or the one or more switch transistors is a thin film transistor.

11. The display system of claim 1, wherein the light-emitting device is an organic light emitting diode and the drive transistor is an n-type or p-type thin film transistor.

12. A method of programming a pixel circuit that drives a current-driven light emitting device independent of a threshold voltage of a drive transistor connected in series to the light

emitting device, the drive transistor being connected between the light emitting device and a controllable power supply such that the controllable power supply is not directly coupled to the light emitting device, the method comprising:

activating a select line to turn on a selection transistor coupled to a gate terminal of the drive transistor;

responsive to the activating the select line, adjusting the controllable power supply to a compensating voltage sufficient to turn off the light emitting device while the select line remains active;

responsive to the adjusting, applying a nonzero reference voltage to the drive transistor through the selection transistor while the select line remains active;

responsive to the adjusting, allowing a node of the pixel circuit to charge or discharge until the drive transistor turns off while the select line remains selected, thereby establishing the threshold voltage of the driving transistor across the drive transistor;

responsive to the drive transistor turning off, applying a programming voltage to the drive transistor, thereby establishing a fixed voltage across the drive transistor according to both the threshold voltage of the drive transistor and the applied programming voltage;

setting the controllable power supply to an operating voltage; and

deselecting the select line to complete the programming cycle and initiate a driving cycle while maintaining the fixed voltage across the drive transistor.

13. The method of claim 12, wherein the current of the driving transistor remains constant during the driving cycle, even if the light emitting device operating voltage changes, due to the fixed voltage being stored in a storage capacitor.

14. The method of claim 12, wherein the reference voltage is sufficient to prevent the light emitting device from being turned on prior to the initiation of the driving cycle.

15. The method of claim 12, wherein the pixel circuit includes a storage capacitor coupled across the gate terminal and a source terminal of the drive transistor, and wherein the node of the pixel circuit allowed to charge or discharge is coupled to the source terminal of the drive transistor such that the allowing the node of the pixel circuit to charge or discharge is carried out by discharging the storage capacitor through the driving transistor until the driving transistor turns off.

16. The method of claim 12, wherein the compensating voltage is also applied to the node of the pixel circuit allowed to charge or discharge, the method further comprising:

adjusting the controllable power supply to a high voltage during the charging or discharging of the node of the pixel circuit so as to speed up the charging or discharging.

17. The method of claim 12, wherein the select line remains selected during the adjusting the controllable voltage supply, the allowing the node to charge or discharge, and the applying the programming voltage.

18. The method of claim 12, wherein the pixel circuit is one of a plurality of pixel circuits arranged in rows and columns to form an active matrix display array, and wherein the method further includes the adjusting, the selecting, the allowing, and the applying for each of the plurality of pixel circuits such that a fixed voltage is established across each of the respective drive transistors according to both the threshold voltage of the respective drive transistor and the respective applied programming voltage.

* * * * *

专利名称(译)	用于编程和驱动具有可控电源电压的有源矩阵发光装置像素的方法和系统		
公开(公告)号	US8378938	公开(公告)日	2013-02-19
申请号	US13/243065	申请日	2011-09-23
[标]申请(专利权)人(译)	伊格尼斯创新公司		
申请(专利权)人(译)	IGNIS创新INC.		
当前申请(专利权)人(译)	IGNIS创新INC.		
[标]发明人	NATHAN AROKIA CHAJI GHOLAMREZA SERVATI PEYMAN		
发明人	NATHAN, AROKIA CHAJI, GHOLAMREZA SERVATI, PEYMAN		
IPC分类号	G09G3/30 G09G3/3225		
CPC分类号	G09G3/3233 G09G3/3696 G09G2300/0842 G09G2300/0852 G09G2310/06 G09G2310/061 G09G2320/043 G09G2310/0262 G09G3/3258 G09G2300/0465		
代理机构(译)	尼克松皮博迪律师事务所		
审查员(译)	阮箬		
优先权	2490858 2004-12-07 CA		
其他公开文献	US20120007842A1		
外部链接	Espacenet USPTO		

摘要(译)

提供了用于编程和驱动有源矩阵发光器件像素的方法和系统。像素是电压编程像素电路，并且具有发光器件，驱动晶体管和存储电容器。像素具有编程周期，该编程周期具有多个操作周期和驱动周期。在编程周期期间，控制OLED和驱动晶体管之间的连接电压，使得驱动晶体管的期望栅极-源极电压存储在存储电容器中。

